

DATA SHEET



SZF2002

Low voltage 8-bit microcontroller
with 6-kbyte embedded RAM

Product specification
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Low voltage 8-bit microcontroller with 6-kbyte embedded RAM

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1 FEATURES

- Fully static 80C51 Central Processing Unit (CPU)
- 8-bit CPU, ROM, RAM and I/O in a 80 lead LQFP package
- 6-kbytes ROM program memory, expandable externally to 256 kbytes
- 6144 + 256 bytes low power RAM data memory, expandable externally to 32 kbytes
- Internal AUX RAM can be used for program execution (only in combination with internal ROM)
- Three 8-bit ports; 24 I/O lines
- Three 16-bit timer/event counters
- Flash Memory Interface optimized, with power saving and programming options
- Internal demultiplexing and latching of address/data bus to reduce system component count
- Interfaces to up to 256-kbyte Flash Memory (banked)
- Fifteen source, fifteen vector nested interrupt structure with two priority levels
- Full duplex serial port (UART)
- I²C-bus interface for serial transfer on two lines
- Analog-to-Digital Converter (ADC) with Power-down mode; 6 input channels and 8-bit ADC
- Pulse Width Modulated (PWM) output (8-bit resolution)
- Watchdog Timer
- Enhanced architecture with:
 - Non-page oriented instructions
 - Direct addressing
 - Four 8-byte RAM register banks
 - Stack depth limited only by available internal RAM (maximum 256 bytes)
 - Multiply, divide, subtract and compare instructions
- Modes of reduced activity: Power-down and Idle modes



- Wake-up via external interrupts at $\overline{\text{INT0}}$ to $\overline{\text{INT8}}$
- Frequency range: up to 16 MHz (only limited by external memory and ADC performance)
- Supply voltage: 3.0 V
- Very low power consumption: operational 0.65 mW/MHz; Idle 0.25 mW/MHz at 3.0 V
- Operating temperature: –40 to +85 °C.

2 GENERAL DESCRIPTION

The SZF2002 low power system controller is manufactured in an advanced 0.5 μm CMOS technology. The instruction set of the SZF2002 is based on that of the 80C51 and consists of over 100 instructions: 49 one-byte, 46 two-byte, and 16 three-byte. The device has low power consumption and two software selectable modes for power reduction: Idle and Power-down.

This data sheet details the specific properties of the SZF2002; for details of the 80C51 core and peripheral functions such as timers, UART and I/O, see "Data Handbook IC20". For the I²C-bus refer to "The I²C-bus and how to use it", ordering number 9398 393 40011.

3 APPLICATIONS

The SZF2002 is an 8-bit general purpose microcontroller especially suited for wireless telephone and battery powered applications. The SZF2002 also functions as an arithmetic processor having facilities for both binary and BCD arithmetic plus bit-handling capabilities.

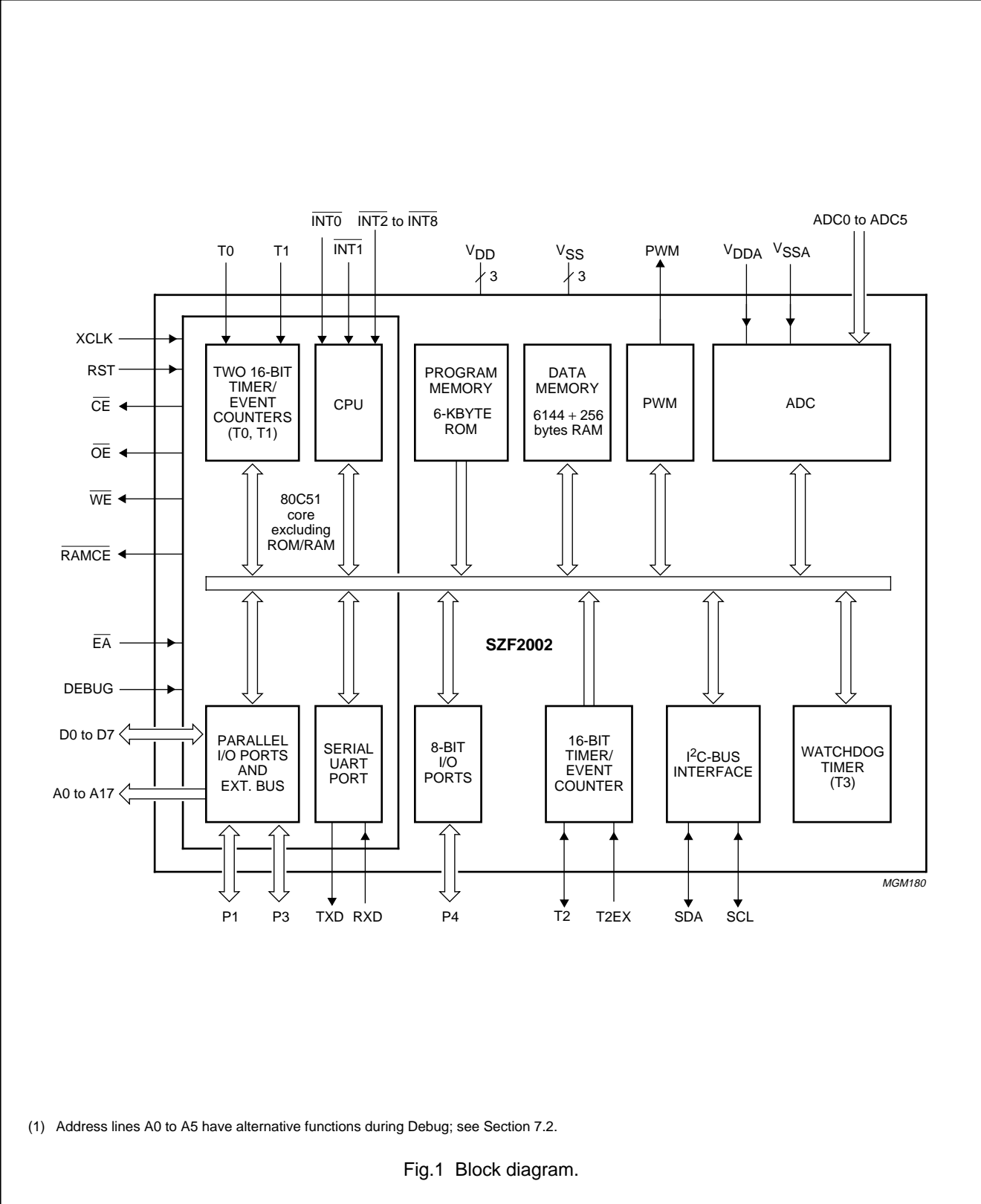
4 ORDERING INFORMATION

TYPE NUMBER	PACKAGE		
	NAME	DESCRIPTION	VERSION
SZF2002HL	LQFP80	plastic low profile quad flat package; 80 leads; body 12 × 12 × 1.4 mm	SOT315-1

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5 BLOCK DIAGRAM



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6 FUNCTIONAL DIAGRAM

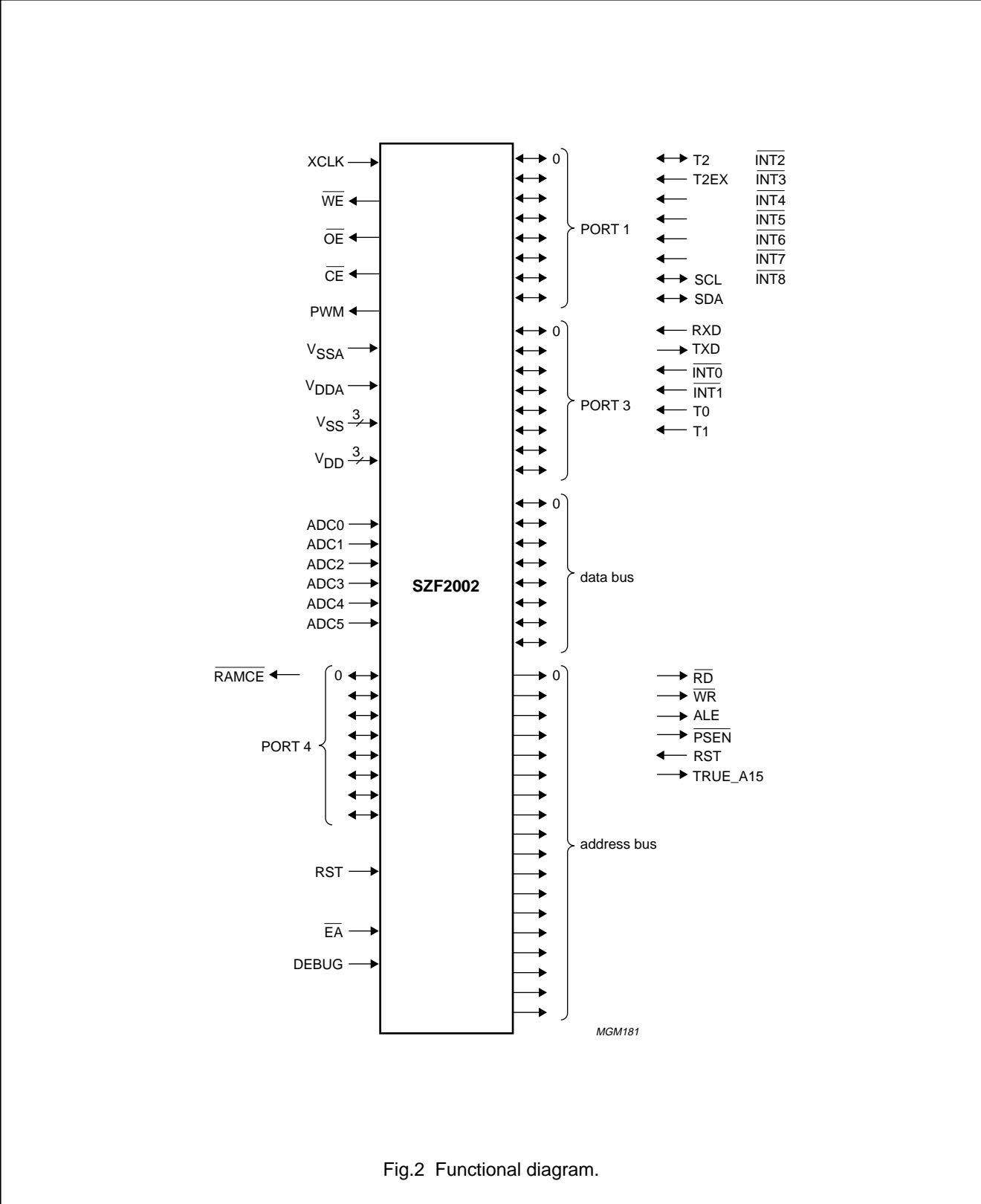


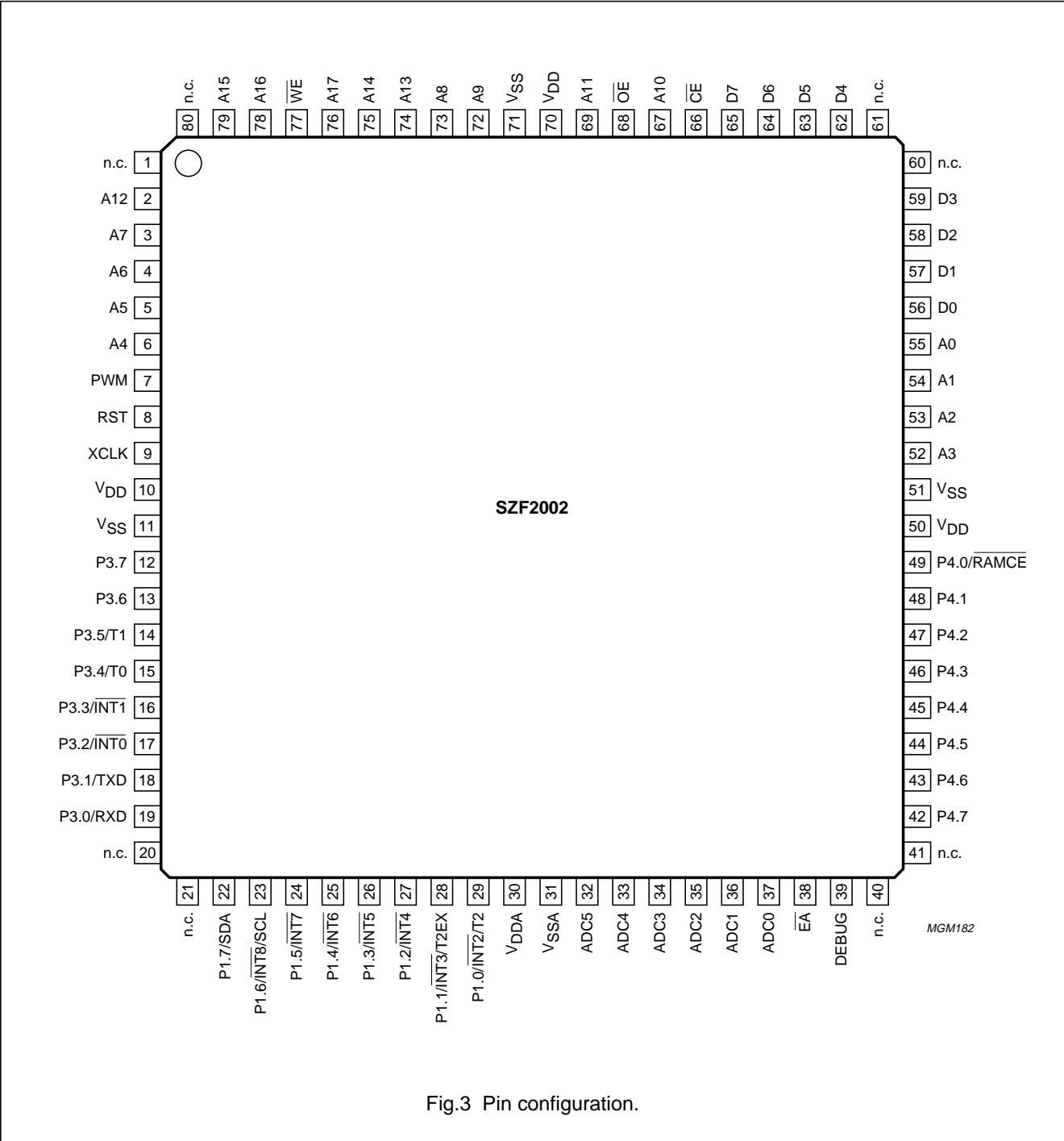
Fig.2 Functional diagram.

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7 PINNING INFORMATION

7.1 Pinning



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7.2 Pin description

Table 1 LQFP80 package

SYMBOL	PIN	DESCRIPTION
Program memory interface; note 1		
A0	55	A0/RD. Address line 0, used as \overline{RD} during Debug.
A1	54	A1/WR. Address line 1, used as \overline{WR} during Debug.
A2	53	A2/ALE. Address line 2, used as ALE during Debug.
A3	52	A3/PSEN. Address line 3, used as \overline{PSEN} during Debug.
A4	6	A4/RST. Address line 4, used as RST during Debug.
A5	5	A5/TRUE_A15. Address line 5, used as A15 = P2.7 during Debug.
A6	4	A6. Address line 6 (not needed during Debug, see D6).
A7	3	A7. Address line 7 (not needed during Debug, see D7).
A8	73	Address lines A8 to A14. During Debug these lines are used as P2.0 to P2.6.
A9	72	
A10	67	
A11	69	
A12	2	
A13	74	
A14	75	
A15	79	Address lines A15 to A17. Page selection; during Debug these lines are the page register. Each bank is 32 kbytes.
A16	78	
A17	76	
D0	56	Data bus. During Debug these line are P0.0 to P0.7.
D1	57	
D2	58	
D3	59	
D4	62	
D5	63	
D6	64	
D7	65	
\overline{CE}	66	Chip Enable. Enable strobe to external program memory.
\overline{OE}	68	Output Enable. Output read strobe to external memory.
\overline{WE}	77	Write Enable. Write strobe to external memory.

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SYMBOL	PIN	DESCRIPTION
I/O Ports		
P1.0/ $\overline{\text{INT2}}$ /T2	29	Port 1 (P1.0 to P1.7). 8-bit bidirectional I/O port with internal pull-ups; $\overline{\text{INT2}}$ to $\overline{\text{INT8}}$: external interrupt inputs; T2 : Timer T2 I/O; T2EX : Timer 2 external input; SCL : I ² C-bus interface clock; SDA : I ² C-bus interface data. Port 1 pins that have logic 1s written to them are pulled HIGH by the internal pull-ups, and in that state can be used as inputs (note P1.6 and P1.7 are open-drain only). As inputs, Port 1 pins that are externally pulled LOW will source current (I_{IL} , see Chapter 25) due to the internal pull-ups.
P1.1/ $\overline{\text{INT3}}$ /T2EX	28	
P1.2/ $\overline{\text{INT4}}$	27	
P1.3/ $\overline{\text{INT5}}$	26	
P1.4/ $\overline{\text{INT6}}$	25	
P1.5/ $\overline{\text{INT7}}$	24	
P1.6/ $\overline{\text{INT8}}$ /SCL	23	
P1.7/SDA	22	
P3.0/RXD	19	Port 3 (P3.0 to P3.7). 8-bit bidirectional I/O port with internal pull-ups; RXD : serial port receiver data input (asynchronous); TXD : serial port transmitter data output (asynchronous); $\overline{\text{INT0}}$: external interrupt 0; $\overline{\text{INT1}}$: external interrupt 1; T0 : Timer 0 external input; T1 : Timer 1 external input. Port 3 pins that have logic 1s written to them are pulled HIGH by the internal pull-ups, and in that state can be used as inputs. As inputs, Port 3 pins that are externally pulled LOW will source current (I_{IL} , see Chapter 25) due to the internal pull-ups.
P3.1/TXD	18	
P3.2/ $\overline{\text{INT0}}$	17	
P3.3/ $\overline{\text{INT1}}$	16	
P3.4/T0	15	
P3.5/T1	14	
P3.6	13	
P3.7	12	
P4.0/ $\overline{\text{RAMCE}}$	49	Port 4 (P4.0 to P4.7). 8-bit bidirectional I/O port; $\overline{\text{RAMCE}}$ chip enable for external RAM. Port 4 pins that have logic 1s written to them are pulled HIGH by the internal pull-ups, and in that state can be used as inputs. As inputs, Port 4 pins that are externally pulled LOW will source current (I_{IL} , see Chapter 25) due to the internal pull-ups.
P4.1	48	
P4.2	47	
P4.3	46	
P4.4	45	
P4.5	44	
P4.6	43	
P4.7	42	
ADC interface		
ADC0	37	Input channels to the ADC.
ADC1	36	
ADC2	35	
ADC3	34	
ADC4	33	
ADC5	32	

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SYMBOL	PIN	DESCRIPTION
General		
PWM	7	Pulse Width Modulation output.
RST	8	Reset. A HIGH level on this pin for at least 12 clock cycles resets the device.
XCLK	9	Clock input.
\overline{EA}	38	External Access. When \overline{EA} is HIGH the CPU executes out of internal program memory (unless the program counter exceeds 7FFFH). A LOW \overline{EA} forces the CPU to execute out of external memory regardless of the value of the Program Counter. This signal is latched at the falling edge of reset (RST pin). The \overline{EA} pin has an internal pull-down. When it is not connected the CPU executes from external memory.
DEBUG	39	DEBUG enable. If HIGH, forces standard 80C51 timing signals output at address and databus. In this mode the databus is multiplexed with the lower 8 bits of the address bus, and the A0 to A3 lines are used for the RD, WR, ALE and PSEN signals. This allows a standard 80C51 in-circuit emulator to be connected. For normal operation connect DEBUG to V _{SS} .
Power		
V _{DD}	10, 50, 70	Power supply digital core and digital I/O pads.
V _{SS}	11, 51, 71	Ground: circuit ground potential.
V _{DDA}	30	Analog power.
V _{SSA}	31	Analog ground.
n.c.	1, 20, 21, 40, 41, 60, 61, 80	Not connected.

Note

1. The pin layout has been optimized for easy connection of 256 kbytes Flash ROM (e.g. ATMEL AT29LV010A, SGS-Thomson M28V201, or AMD Am29F010).

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8 FUNCTIONAL DESCRIPTION

Detailed descriptions of each function are described in:

- Chapter 9 "Memory organization"
- Chapter 10 "Program Status Word (PSW)"
- Chapter 11 "I/O facilities"
- Chapter 12 "Timer/event counters"
- Chapter 13 "Pulse Width Modulated output"
- Chapter 14 "Analog-to-digital converter (ADC)"
- Chapter 15 "Reduced power modes"
- Chapter 16 "I²C-bus serial I/O"
- Chapter 17 "Standard serial interface SIO0: UART"
- Chapter 18 "Interrupt system"
- Chapter 19 "Clock circuitry"
- Chapter 20 "Reset"
- Chapter 21 "Special Function Registers overview"
- Chapter 22 "Debugging support".

8.1 General

The SZF2002 is a stand-alone high-performance CMOS microcontroller designed for use in real-time applications such as wireless telephone and mobile communications, instrumentation, industrial control, intelligent computer peripherals and consumer products.

The device provides hardware features, architectural enhancements and new instructions to function as a controller for applications requiring up to 256 kbytes of program memory and/or up to 6 144 + 256 bytes of on-chip data memory.

The SZF2002 contains a 6-kbyte program memory; a static 6 144 + 256 byte data memory (RAM); 24 I/O lines; three 16-bit timer/event counters; a fifteen-source two priority-level, nested interrupt structure, a 6-channel 8-bit ADC, a Watchdog Timer and a Pulse Width Modulation output.

Two serial interfaces are provided on-chip:

- A standard UART serial interface
- A standard I²C-bus serial interface with a transfer speed of up to 400 kbits/s (depending on clock frequency). The I²C-bus serial interface has byte oriented master and slave functions allowing communication with the whole family of I²C-bus compatible devices.

The device has two software selectable modes of reduced activity for power reduction:

- **Idle mode:** freezes the CPU while allowing the derivative functions (timers, serial I/O, RAM, ADC and PWM) and interrupt system to continue functioning
- **Power-down mode:** saves the RAM contents but stops the clock causing all other chip functions to be inoperative.

8.2 CPU timing

A machine cycle consists of a sequence of 6 states. Each state lasts one clock period, thus a machine cycle takes 6 clock periods or 1 μ s if the clock frequency (f_{clk}) is 6 MHz.

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9 MEMORY ORGANIZATION

The SZF2002 has 6 kbytes of program memory plus 6 kbytes + 256 bytes of data memory on chip. The device has separate address spaces for program and data memory (see Fig.4).

The SZF2002 can directly address up to 256 kbytes of external data memory. The CPU generates the read strobe (\overline{OE}), the write strobe (\overline{WE}) and chip select (\overline{CE}) for external program memory (Flash), and read strobe (\overline{OE}) and write strobe (\overline{WE}) and chip select (\overline{RAMCE}) for external data memory.

9.1 Program memory

The SZF2002 contains 6 kbytes of internal ROM and 6144 + 256 bytes of RAM. The lower 6 kbytes of program memory can be implemented in either on-chip ROM or external program memory. The 6 kbytes of program memory is implemented as mask programmable ROM.

There are two modes for the program memory, depending on the state of the \overline{EA} pin (latched during reset) and on the address range:

1. $\overline{EA} = 0$. All program fetches are directed to the external program memory. After reset the CPU begins execution at location 8000H.
2. $\overline{EA} = 1$. After reset the CPU begins execution at location 0000H. Fetches from addresses 2000H to 37FFH are redirected to the Auxiliary RAM. The processor can fill this RAM with normal write operations to the data memory (MOVX to addresses 0000H to 17FFH). Program memory fetches from addresses 0000H to 17FFH are directed to the internal ROM.

Program Counter values greater than 7FFFH are automatically addressed to external memory regardless of the state of the \overline{EA} pin.

9.2 Data memory

The SZF2002 contains 6144 + 256 bytes of RAM and a number of Special Function Registers (SFRs). All these data spaces are addressed differently. Figure 4 shows the internal data memory space divided into the lower 128 bytes, the upper 128 bytes, Auxiliary RAM, and the SFRs space. Internal RAM locations 0 to 127 are directly and indirectly addressed. Internal RAM locations 128 to 255 are only indirectly addressed.

The Special Function Register locations 128 to 255 are only directly addressed. Auxiliary RAM is accessible via MOVX instructions to the lower 32-kbyte address space. MOVX @R0/R1 instructions use SFR P2 as page selector. The upper 32-kbyte address space is redirected to the program memory, to accommodate flash programming.

9.3 Special Function Registers (SFRs)

The upper 128 bytes are the address locations of the SFRs. Figures 6 and 7 show the Special Function Registers space. The SFRs include the port latches, timers, peripheral control, serial I/O registers, etc. These registers are accessed by direct addressing. There are 128 directly addressed locations in the SFR address space. Bit addressed SFRs are those that end in 000B.

9.4 Addressing

The SZF2002 has five methods for addressing source operands:

- Register
- Direct
- Indirect
- Immediate
- Base-Register plus Index-Register-Indirect.

The first three methods can be used for addressing destination operands. Most instructions have a 'destination/source' field that specifies the data type, addressing methods and operands involved. For operations other than MOVs, the destination operand is also a source operand.

Access to memory addressing is as follows:

- Registers in one of the four register banks through Direct or Indirect (see Fig.5)
- Lower 128 bytes of internal RAM through Direct or register Indirect; upper 128 bytes of internal RAM through Indirect
- Special Function Registers through Direct
- Program memory look-up tables through Base-Register plus Index-Register-Indirect
- Extended data memory access through register Indirect.

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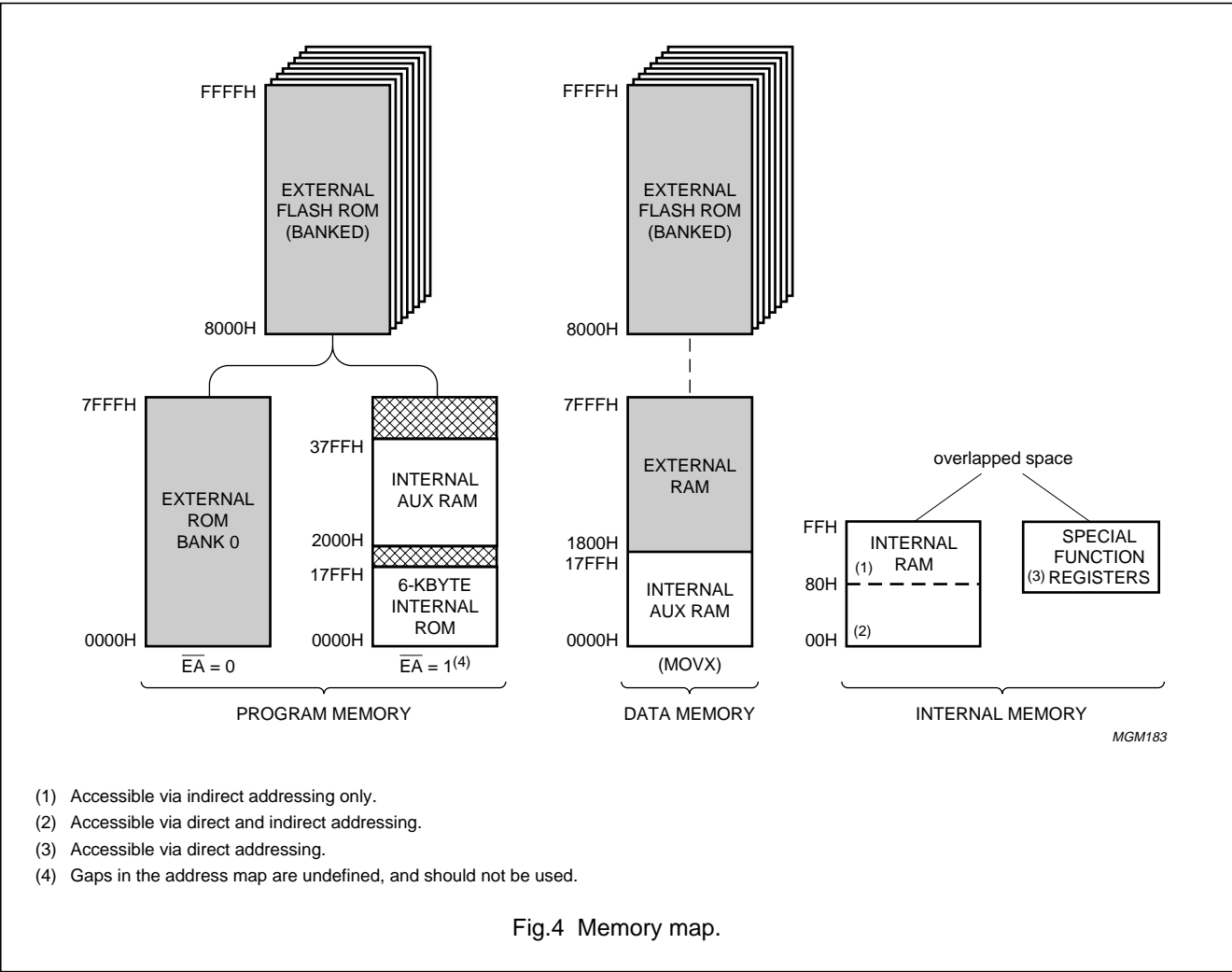


Table 2 Memory spaces; note 1

MEMORY SPACE	ADDRESS MODE	USED SIGNAL
Internal RAM 00H to 7FH	direct and indirect	–
Internal RAM 80H to FFH	indirect	–
SFRs 80H to FFH	direct	–
Internal AUX RAM (on-chip) 0000H to 17FFH	MOVX	–
External RAM (off-chip) 1800H to 7FFFH	MOVX	\overline{RAMCE} , \overline{OE} and \overline{WE}
External ROM (off-chip) 0000H to FFFFH; note 2	program execution	\overline{CE} , \overline{OE}
Internal AUX RAM (on-chip) 2000H to 37FFH	program execution	–
External Flash ROM write (off-chip) 8000H to FFFFH; note 2	MOVX	\overline{CE} , \overline{OE} and \overline{WE}

Notes

1. Execution from internal memory is only possible when $\overline{EA} = 1$ during reset.
2. Page select is used to access all 8 banks in the 256-kbyte address space.

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9.5 Paging logic

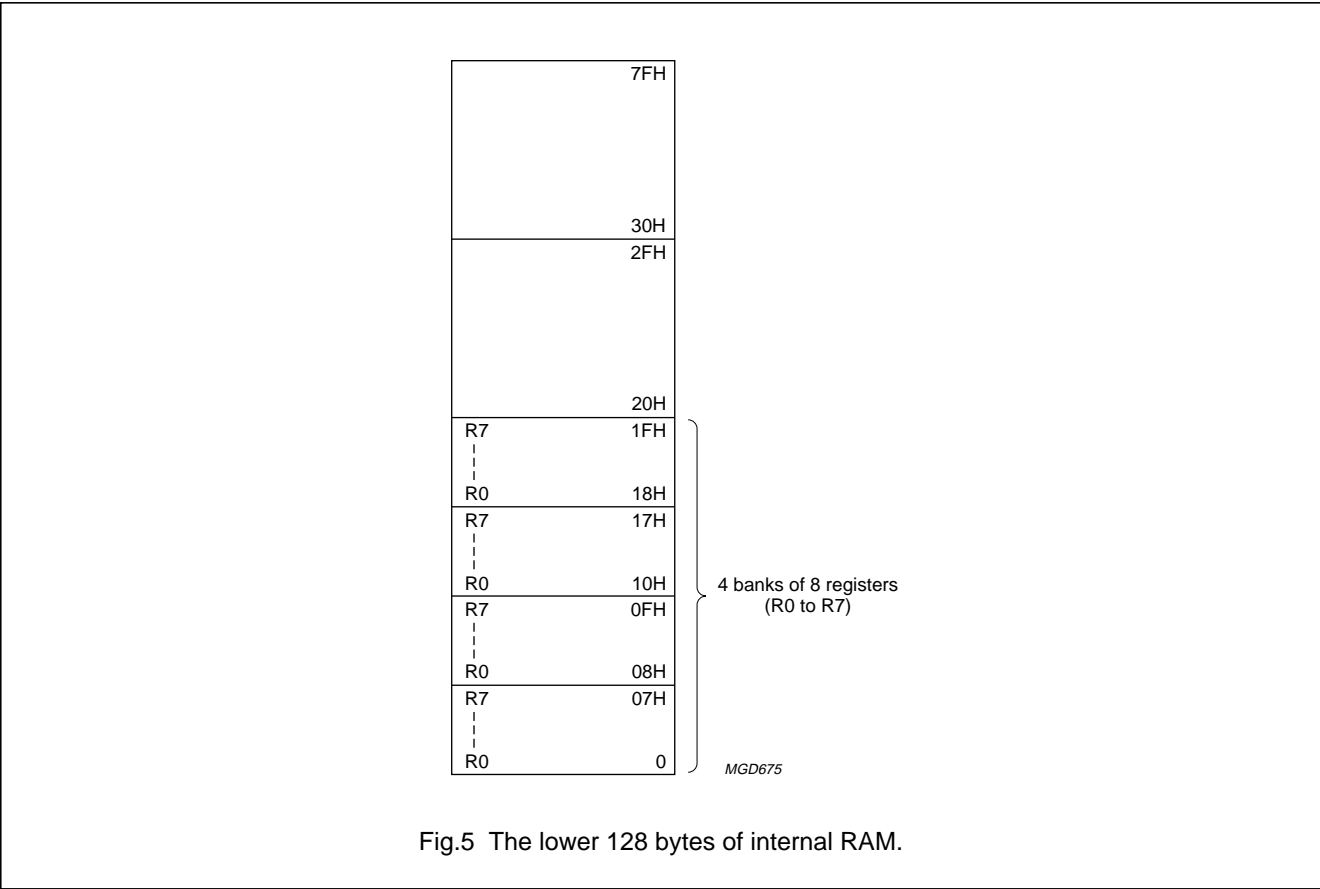
The SZF2002 contains paging logic to handle the extended address range.

Table 3 Paging of external memory; notes 1 and 2

TRUE_A15 (INTERNAL)	BANK SFR [2 : 0]	A<17-15> PINS	BANK	REMARK
0	XXX	000	0	lower 32 kbytes always bank 0
1	000	000	0	bank 0
1	001	001	1	bank 1
1	010	010	2	bank 2
1	011	011	3	bank 3
1	100	100	4	bank 4
1	101	101	5	bank 5
1	110	110	6	bank 6
1	111	111	7	bank 7

Notes

1. During Debug A<17-15> are used to output the bank register. The TRUE_ A15 line is output at the A5 pin.
2. During Debug ROM and RAM access is done via $\overline{\text{PSEN}}$, $\overline{\text{WR}}$ and $\overline{\text{RD}}$.



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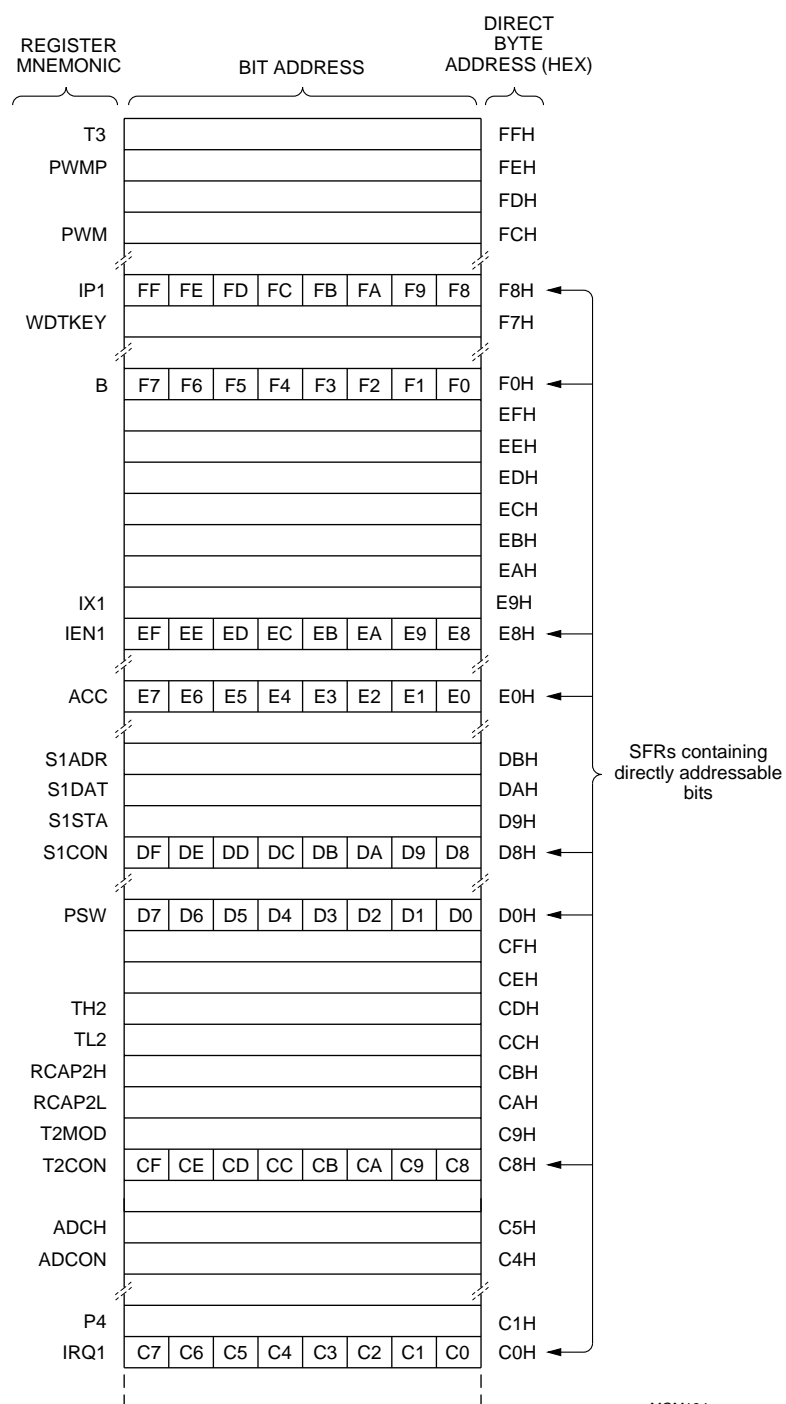


Fig.6 Special Function Register memory map.

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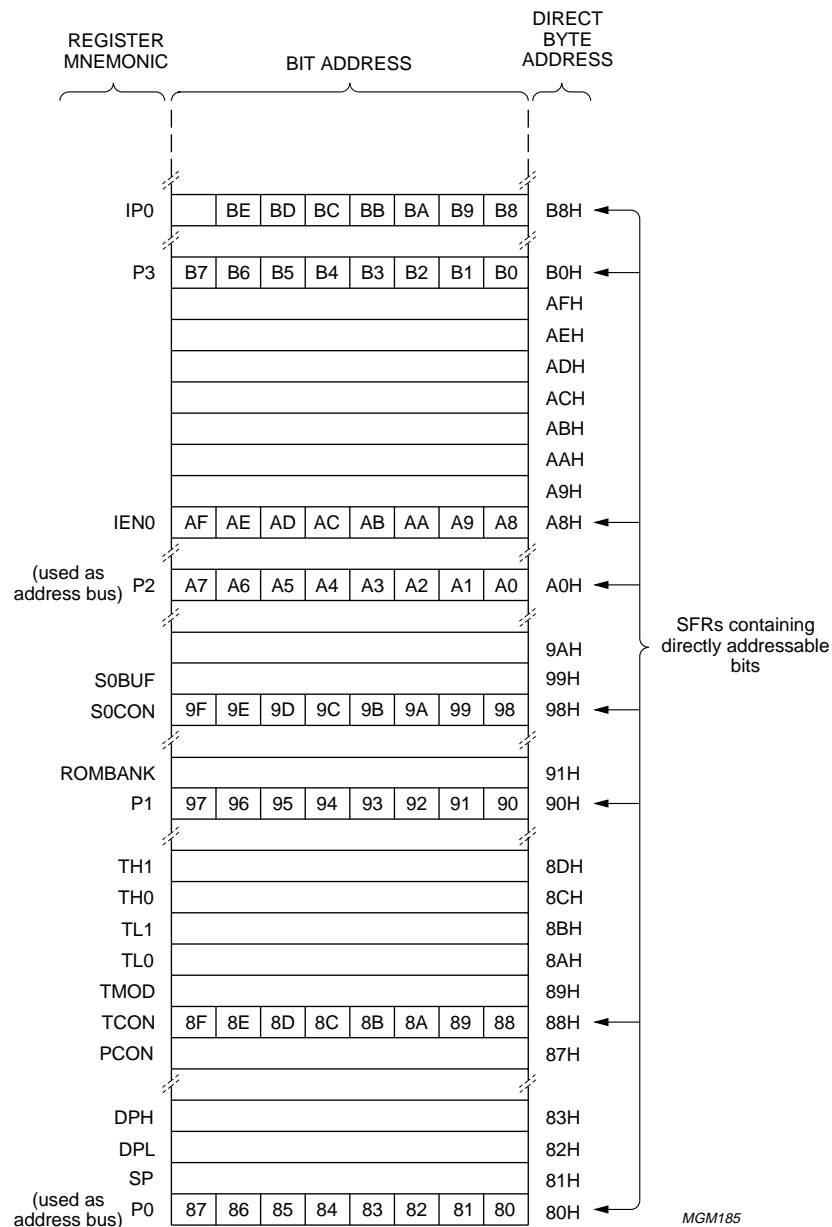


Fig.7 Special Function Register memory map (continued from Fig.6).

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10 PROGRAM STATUS WORD (PSW)

The Program Status Word contains several status bits that reflect the current state of the CPU. The PSW, shown in Table 4, resides in the SFR memory space. It contains the Carry bit, the Auxiliary Carry (for BCD operations), the two register bank select bits, the Overflow flag, a Parity bit and two user-definable status flags.

The Carry bit, other than serving the function of a Carry bit in arithmetic operations, also serves as the Accumulator for a number of boolean operations.

Bits RS0 and RS1 are used to select one of the four register banks; see Table 5. A number of instructions refer

to these RAM locations as R0 through to R7. The selection of which of the four register banks is being referred to is made on the basis of the state of RS0 and RS1 at execution time.

The Parity bit reflects the number of 1s in the Accumulator: P = 1, if the Accumulator contains an odd number of 1s, and P = 0, if the Accumulator contains an even number of 1s. Thus, the number of 1s in the Accumulator plus P is always even. The bits F0 and USR are uncommitted and may be used as general purpose status flags.

Table 4 Program Status Word (SFR address D0H)

7	6	5	4	3	2	1	0
CY	AC	F0	RS1	RS0	OV	USR	P

Table 5 Description of PSW bits

BIT	SYMBOL	DESCRIPTION
7	CY	Carry flag. The Carry flag receives carry out from bit 7 of ALU operands.
6	AC	Auxiliary Carry flag. The Auxiliary Carry flag receives carry out from bit 3 of addition operands.
5	F0	General purpose status flag.
4	RS1	Register Bank Select 1. This bit selects Register Bank 1.
3	RS0	Register Bank Select 0. This bit selects Register Bank 0.
2	OV	Overflow flag. This flag is set by arithmetic operations.
1	USR	USR. This is a user-definable flag.
0	P	Parity. If the Accumulator contains an odd number of 1s this bit is set to a logic 1 by hardware. Otherwise, the state of this bit is a logic 0.

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11 I/O FACILITIES

11.1 Ports

The SZF2002 has 24 I/O lines: ports P1, P3 and P4 of which ports P1 and P3 are bit addressed (P0 and P2 are always used as address/data bus). Ports 0 to 4 have the following alternative functions:

Port 0 Used internally.

Port 1 Used for a number of special functions:

- Provides the inputs for the external interrupts: $\overline{\text{INT2}}$ to $\overline{\text{INT8}}$
- The I²C-bus interface: SCL and SDA
- Counter inputs: T2 and T2EX.

Port 2 Used internally.

Port 3 Pins can be configured individually to provide:

- External interrupt request inputs: $\overline{\text{INT1}}$ and $\overline{\text{INT0}}$
- Counter input: T1 and T0
- UART input and output: RXD and TXD.

Port 4 Provides chip select for external data memory: $\overline{\text{RAMCE}}$.

To enable a port pin alternative function, the port bit latch in its SFR must contain a logic 1.

Each port consists of a latch (SFRs P0 to P4), an output driver and input buffer. Ports 1, 3 and 4 have internal pull-ups (except P1.6 and P1.7). Figure 8 shows that the strong transistor 'p1' is turned on for only 2 clock periods after a LOW-to-HIGH transition in the port latch. When on, it turns on 'p3' (a weak pull-up) through the inverter. This inverter and 'p3' form a latch which holds the logic 1. In Port 0 the pull-up 'p1' is only on when emitting logic 1s for external memory access.

11.2 Port configuration

The port pins (except for P1.6 and P1.7) are configured as shown in Fig.8. This is a quasi-bidirectional I/O with pull-up. The strong booster pull-up 'p1' is turned on for one clock period after a LOW-to-HIGH transition in the port latch. All port pins will be set to HIGH during reset.

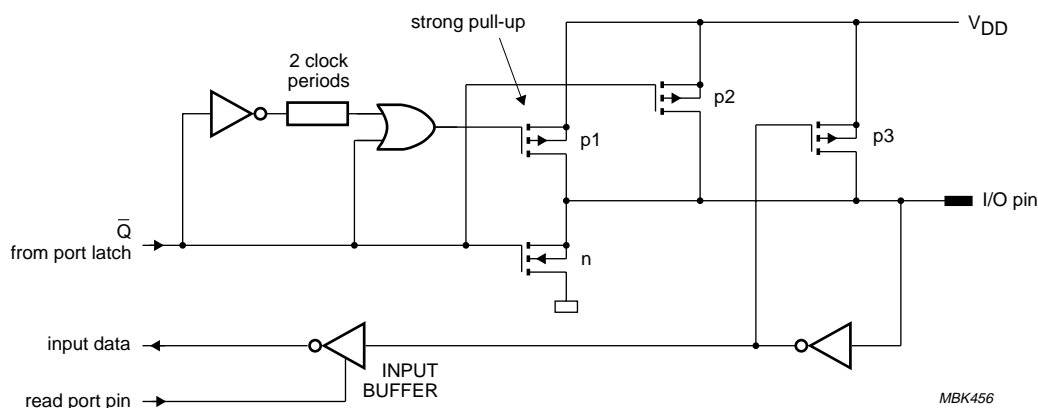


Fig.8 Port configuration.

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12 TIMER/EVENT COUNTERS

The SZF2002 contains three 16-bit timer/event counter registers; Timer 0, Timer 1 and Timer 2 which can perform the following functions:

- Measure time intervals and pulse duration
- Count events
- Generate interrupt requests.

In the 'Timer' operating mode the register increments every machine cycle. Since a machine cycle consists of 6 clock periods, the count rate is $\frac{1}{6}f_{\text{clk}}$.

In the 'Counter' operating mode, the register increments in response to a HIGH-to-LOW transition. Since it takes 2 machine cycles (12 clock periods) to recognize a HIGH-to-LOW transition, the maximum count rate is $\frac{1}{12}f_{\text{clk}}$. To ensure a given level is sampled, it should be held for at least one complete machine cycle.

12.1 Timer 0 and Timer 1

Timer 0 and Timer 1 can be programmed independently to operate in four modes:

- Mode 0 8-bit timer or 8-bit counter each with divide-by-32 prescaler.
- Mode 1 16-bit time-interval or event counter.
- Mode 2 8-bit time-interval or event counter with automatic reload upon overflow.
- Mode 3 Timer 0 establishes TL0 and TH0 as two separate counters.

12.2 Timer 2

Timer 2 is a 16-bit timer/up-down counter that can operate (like Timer 0 and 1) either as a timer or as an event counter. These functions are selected by the state of the $C/\overline{T}2$ bit in the T2CON register; see Section 12.3.

Three operating modes are available: Capture, Auto-reload and Baud Rate Generator, which also are selected via the T2CON register.

12.2.1 CAPTURE MODE

Figure 9 shows the Capture mode. Two options in this mode may be selected by the EXEN2 bit in T2CON:

- If EXEN2 = 0, then Timer 2 is a 16-bit timer or counter that sets the Timer 2 overflow bit (TF2) on overflow, this can be used to generate an interrupt.

- If EXEN2 = 1, Timer 2 operates as already described but with the additional feature that a HIGH-to-LOW transition at external input T2EX causes the current value in TL2 and TH2 to be captured into registers RCAP2L and RCAP2H respectively. In addition, the transition at T2EX causes the EXF2 bit in T2CON to be set; this may also be used to generate an interrupt.

12.2.2 AUTO-RELOAD MODE

Figure 10 shows the Auto-reload mode.

- Counting up (DCEN = 0)

In the Auto-reload mode and counting up, registers RCAP2L/RCAP2H are used to hold a reload value for TL2/TH2 when Timer 2 rolls over. By setting/clearing bit EXEN2 in T2CON the external trigger input pin T2EX can be enabled/disabled. If EXEN2 = 0, then Timer 2 is a 16-bit timer/counter which upon overflow sets TF2, and reloads TL2/TH2 with the reload value held in RCAP2L/RCP2H. If EXEN2 = 1, then Timer 2 performs as above, but with the added feature that a HIGH-to-LOW transition at pin T2EX causes the current Timer 2 value (TL2/TH2 data) to be reloaded with the value held in RCAP2L/RAP2H, and bit EXF2 in T2CON to be set.

Timer 2 interrupt will be set if EXF2 is set or TF2 is set.

- **Counting up (DCEN = 1 and T2EX = 1).** In this mode Timer 2 will count up. When the timer overflows (FFFFH state), TF2 bit will be set. This will reload TL2 and TH2 with the contents of T2CAPL and T2CAPH, respectively. Also bit EXF2 will be toggled. Bit EXF2 can be used as the 17th bit if desired.

Timer 2 interrupt will be set only if TF2 is set.

- **Counting down (DCEN = 1 and T2EX = 0.** In this mode Timer 2 will be counting down. Underflow will occur when the contents of TL2/TH2 matches the contents of RCAP2L/RCAP2H. A Timer 2 roll-over from 0000H to FFFFH is not considered as an underflow. Upon underflow, bit TF2 will be set and registers TL2/TH2 will be loaded with FFFFH. In addition, an underflow will cause bit EXF2 to toggle, such that it can be used as the 17th bit if desired.

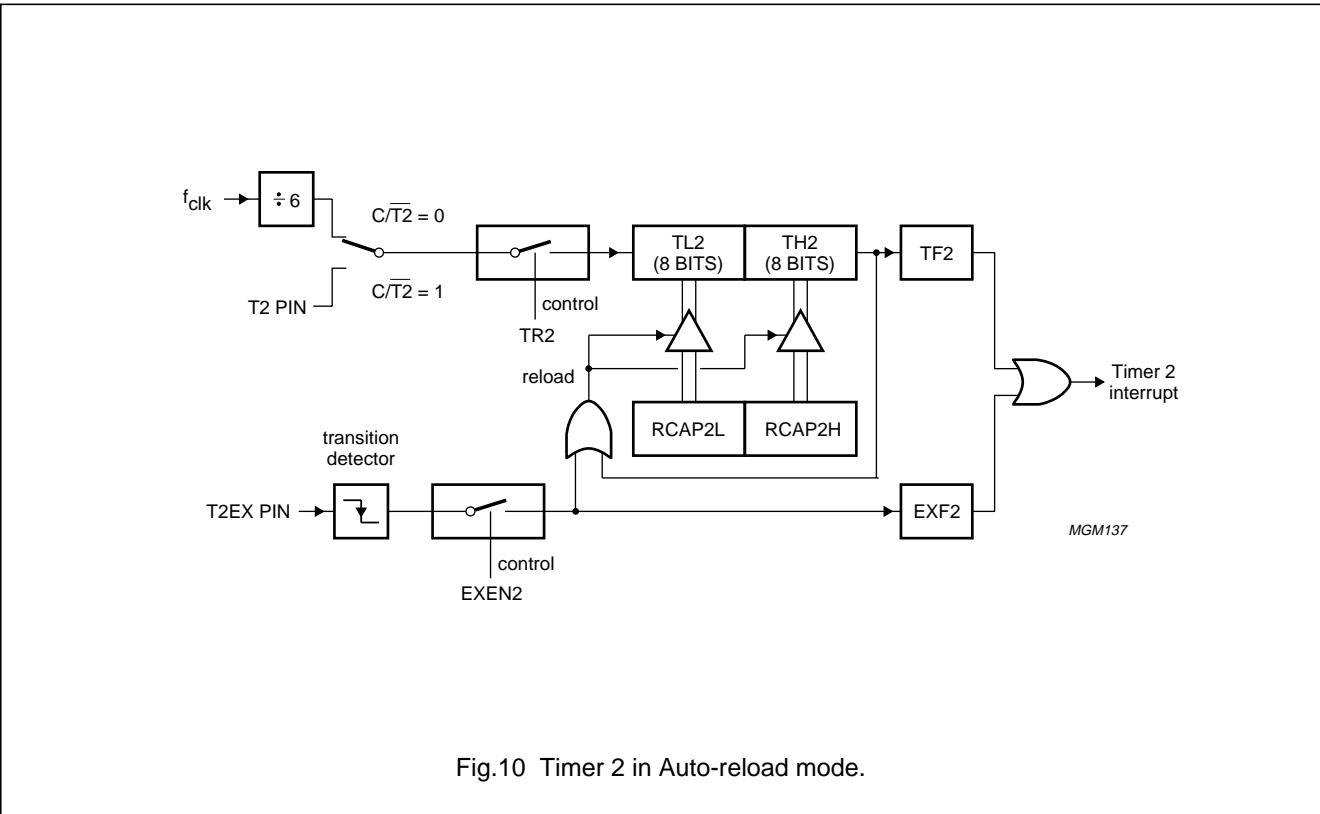
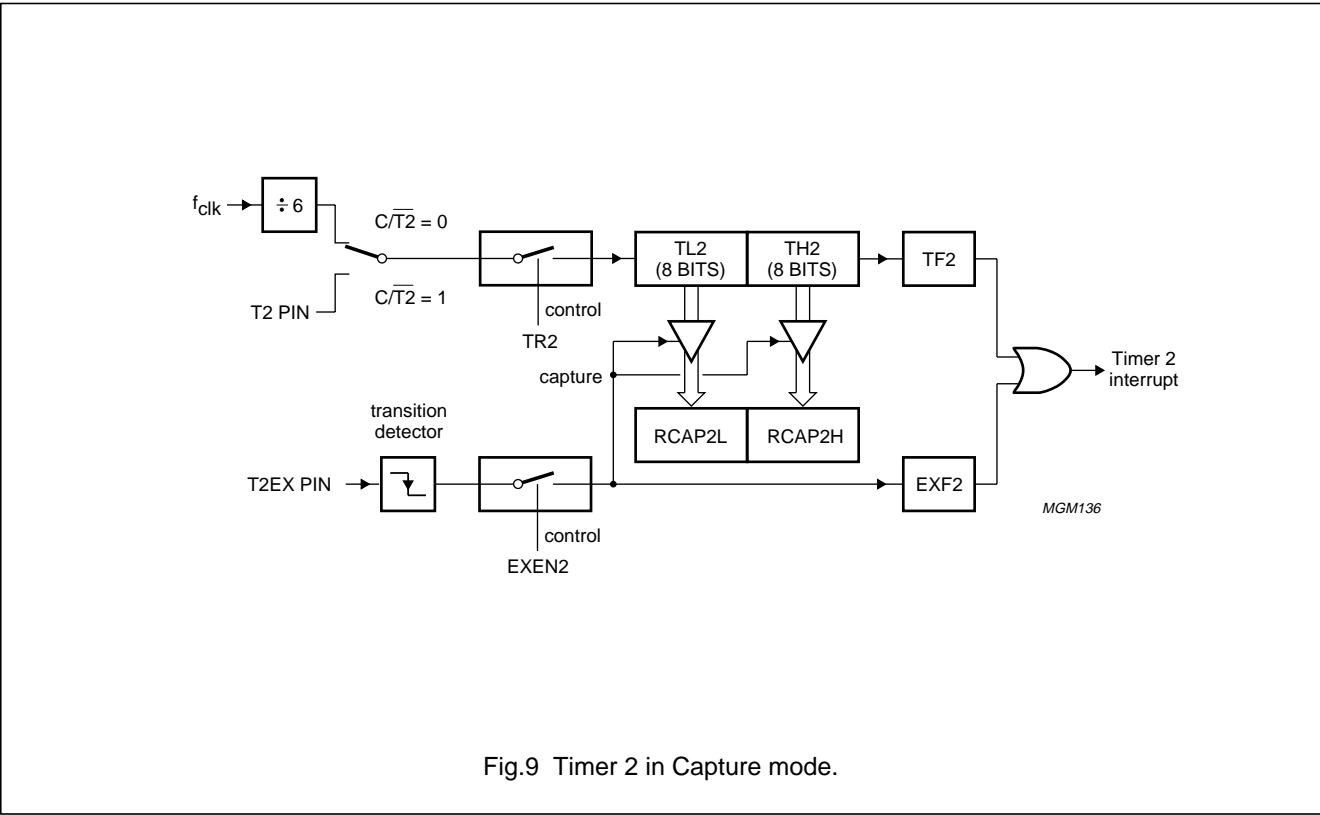
Timer 2 interrupt will be set only if TF2 is set.

12.2.3 BAUD RATE GENERATOR MODE

The Baud Rate Generator mode is selected when RCLK0 = 1 or TCLK0 = 1 or RCLK1 = 1 or TCLK1 = 1. It will be described in conjunction with the serial port (UART); see Section 17.3.2.

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12.3 Timer/Counter 2 Control Register (T2CON)

Table 6 Timer/Counter 2 Control Register (SFR address C8H)

7	6	5	4	3	2	1	0
TF2	EXF2	RCLK0	TCLK0	EXEN2	TR2	C/T2	CP/RL2

Table 7 Description of T2CON bits

BIT	SYMBOL	DESCRIPTION
7	TF2	Timer 2 overflow flag. Set by a Timer 2 underflow or overflow and must be cleared by software. TF2 will not be set when in either the Baud Rate generation mode or Clock out mode.
6	EXF2	Timer 2 external flag. Set when either a capture or reload is caused by a negative transition on T2EX and when EXEN2 = 1. In Auto-reload mode it is toggled on an underflow or overflow. Cleared by software.
5	RCLK0	Receive clock 0 flag. When set, causes the UART to use Timer 2 overflow pulses. RCLK0 = 0, causes Timer 1 overflow pulses to be used.
4	TCLK0	Transmit clock 0 flag. When set, causes the UART to use Timer 2 overflow pulses. TCLK0 = 0, causes Timer 1 overflow pulses to be used.
3	EXEN2	Timer 2 external enable flag. When set, allows a capture or reload to occur, together with an interrupt, as a result of a negative transition on input T2EX (if in Capture mode or Auto-reload mode with DCEN reset). If in Auto-reload mode and DCEN is set, this bit has no influence. In the other modes EXF2 is set and an interrupt is generated on a HIGH-to-LOW transition on T2EX pin. In all modes EXEN2 = 0, causes Timer 2 to ignore events at T2EX.
2	TR2	Timer 2 start/stop control. When TR2 = 1, Timer 2 is started.
1	C/T2	Timer or counter select for Timer 2. C/T2 = 0, selects the internal timer with a clock frequency of $\frac{1}{6}f_{\text{clk}}$. C/T2 = 1, selects the external event counter; negative edge triggered.
0	CP/RL2	Capture/Reload flag. Selection of Capture or Auto-reload mode.

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12.4 Timer/Counter 2 Mode Register (T2MOD)

Table 8 Timer/Counter 2 Mode Register (SFR address C9H)

7	6	5	4	3	2	1	0
–	–	RCLK1	TCLK1	–	T2RD	T2OE	DCEN

Description of T2MOD bits

BIT	SYMBOL	DESCRIPTION
7	–	These 2 bits are reserved.
6	–	
5	RCLK1	Receive Clock 1 flag. Reserved for future UART2. When set, causes the UART to use Timer 2 overflow pulses. RCLK1 = 0, causes Timer 1 overflow pulses to be used.
4	TCLK1	Transmit Clock 1 flag. Reserved for future UART2. When set, causes the UART to use Timer 2 overflow pulses. TCLK1 = 0, causes Timer 1 overflow pulses to be used.
3	–	This bit is reserved.
2	T2RD	Timer 2 Read flag. This bit is set by hardware if following a TL2 read and before a TH2 read, TH2 is incremented. It is reset on the trailing edge of the next TL2 read.
1	T2OE	Timer 2 Output Enable. When set, output is activated to output a clock at the T2 pin (Clock output mode).
0	DCEN	Down Count Enable. When set, this allows Timer 2 to be configured as an up/down counter.

Table 9 Timer 2 operating modes; note 1

RCLK0 + TCLK0 + RCLK1 + TCLK1	CP/RL2	T2OE	C/T2	MODE
0	0	0	X	16-bit Auto-reload
0	1	0	X	16-bit Capture
1	X	X	X	Baud Rate Generator

Note

1. X = don't care

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12.5 Watchdog Timer (T3)

In addition to Timer 2 and the standard timers, a Watchdog Timer (consisting of an 11-bit prescaler and an 8-bit timer) is also available.

The Watchdog Timer is controlled by the Watchdog Enable Register (WDTKEY). When WDTKEY = 55H, the timer is disabled and the Power-down mode is enabled. Otherwise, the timer is enabled and the Power-down mode is disabled. In the Idle mode the Watchdog Timer and reset circuitry remain active.

The Watchdog Timer is shown in Fig.11.

The timer frequency is derived from the clock frequency using the formula shown below:

$$f_{\text{timer}} = \frac{f_{\text{clk}}}{(6 \times 2048) \times T3}$$

When a timer overflow occurs, the microcontroller is reset. To prevent a system reset the timer must be reloaded in time by the application software.

If the processor suffers a hardware/software malfunction, the software will fail to reload the timer. This failure will produce a reset upon overflow thus preventing the processor running out of control.

The Watchdog Timer can only be reloaded if the condition flag WLE (PCON.4) has been previously set by software. At the moment the counter is loaded the condition flag is automatically cleared. After reset the Watchdog Timer is off. The Watchdog Timer is started by loading a value into T3.

The time interval between the timer reloading and the occurrence of a reset is dependent upon the reloaded value. The time interval is derived from the clock and the value programmed into T3 and may be calculated as shown below:

$$T_{\text{reload}} = \frac{(256 - T3)}{f_{\text{timer}}}$$

For example, this time period may range from 2 to 500 ms when using a clock frequency $f_{\text{clk}} = 6 \text{ MHz}$.

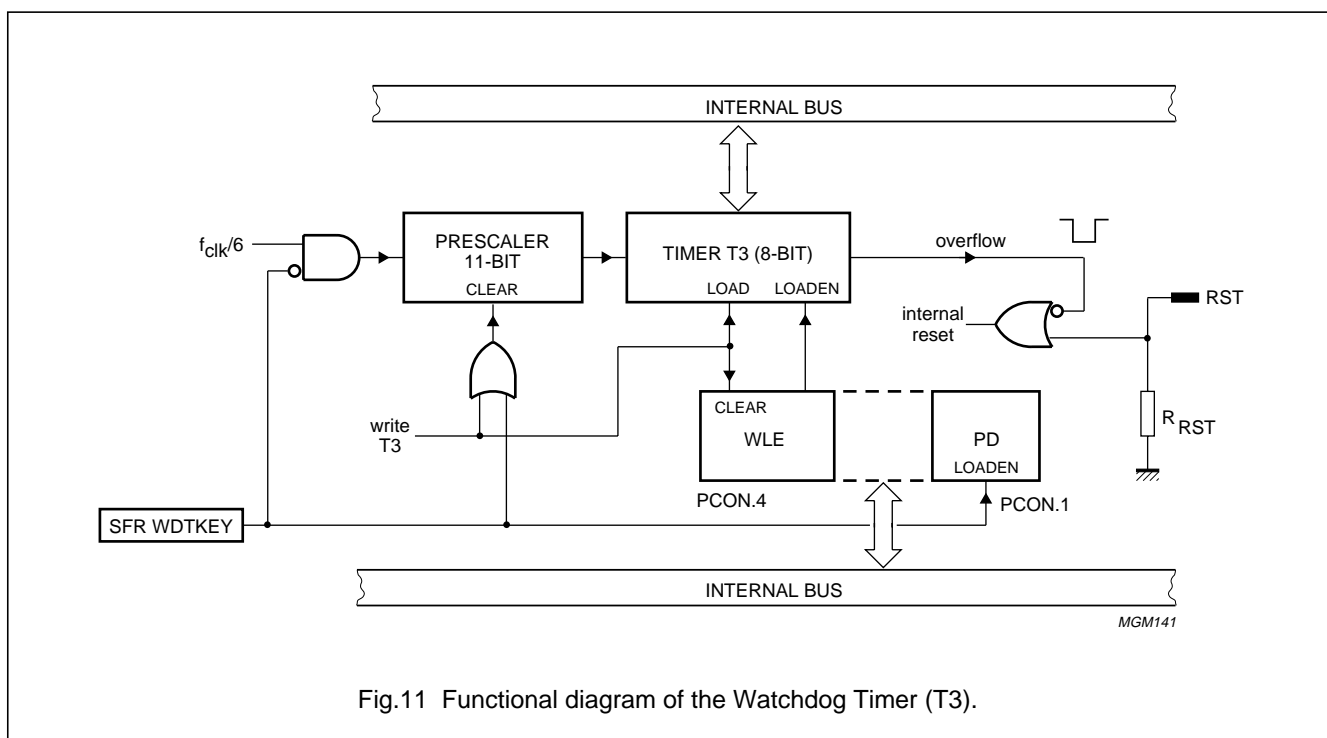


Fig.11 Functional diagram of the Watchdog Timer (T3).

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13 PULSE WIDTH MODULATED OUTPUT

One Pulse Width Modulated output channel PWM is provided which outputs pulses of programmable length and interval. The repetition frequency is defined by an 8-bit prescaler (PWMP) that generates the clock for the counter. The 8-bit counter counts modulo 255, i.e. from 0 to 254 inclusive. The value held in the 8-bit counter is compared to the contents of the register PWM. If a new prescaler value is written in register PWMP the 8-bit counter finishes uninterrupted, and the new prescaler value is used in the next count cycle.

Provided the contents of this register are greater than the counter value, the PWM output is set HIGH. If the contents of register PWMP are equal to, or less than the counter value, the PWM output is set LOW.

The pulse-width-ratio is therefore defined by the contents of register PWM. The pulse-width-ratio will be in the range 0 to $\frac{255}{255}$ and may be programmed in increments of $\frac{1}{255}$.

The repetition frequency (f_{PWM}) at the PWM output is given by:

$$f_{\text{PWM}} = \frac{f_{\text{clk}}}{(1 + \text{PWMP}) \times 255 \times 2}$$

For $f_{\text{clk}} = 12 \text{ MHz}$, the above formula gives a repetition frequency range of 92 Hz to 23.5 kHz.

By loading the PWM register with either 00H or FFH, the PWM output can be retained at a constant LOW or HIGH level respectively. When loading FFH into the PWM register, the 8-bit counter will never actually reach this value.

The PWM output pin is not shared with any other function.

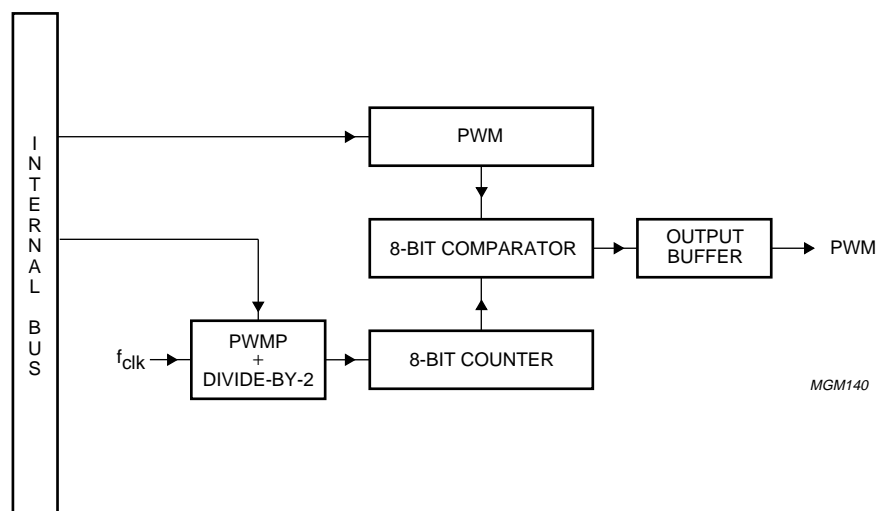


Fig.12 Functional diagram of Pulse Width Modulated output (PWM).

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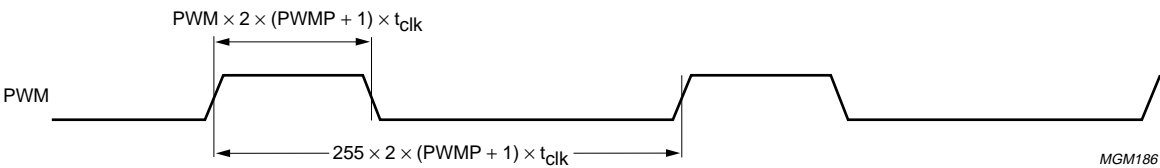


Fig.13 PWM signals.

13.1 Prescaler Frequency Control Register (PWMP)

Table 10 Prescaler Frequency Control Register (SFR address FEH)

7	6	5	4	3	2	1	0
PWMP.7	PWMP.6	PWMP.5	PWMP.4	PWMP.3	PWMP.2	PWMP.1	PWMP.0

Table 11 Description of PWMP bits

BIT	SYMBOL	DESCRIPTION
7 to 0	PWMP.7 to PWMP.0	prescaler division factor = (PWMP) + 1

13.2 Pulse Width Register (PWM)

Table 12 Pulse Width Register (SFR address FCH)

7	6	5	4	3	2	1	0
PWM.7	PWM.6	PWM.5	PWM.4	PWM.3	PWM.2	PWM.1	PWM.0

Table 13 Description of PWM bits

BIT	SYMBOL	DESCRIPTION
7 to 0	PWM.7 to PWM.0	HIGH/LOW ratio of PWM signal = $\frac{(PWM)}{\{255 - (PWM)\}}$

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14 ANALOG-TO-DIGITAL CONVERTER (ADC)

The analog input circuitry consists of a 6-input analog multiplexer and an ADC with 8-bit resolution. The analog supply (V_{DDA}) and analog ground (V_{SSA}) are connected via separate input pins. For clock frequencies higher than 8 MHz the clock prescaler is needed (divide-by-2). The functional diagram of the ADC is shown in Fig.14.

The ADC is controlled using the ADC Control Register (ADCON). Input channels are selected by the analog multiplexer via the ADCON register bits AADR0 to AADR2.

A conversion is started by setting the ADCS bit in the ADCON register. The completion of the 8-bit ADC conversion is flagged by ADIF in the ADCON register, which will generate an interrupt if this is enabled (EAD). The result is stored in the Special Function Register ADCH (address C5H).

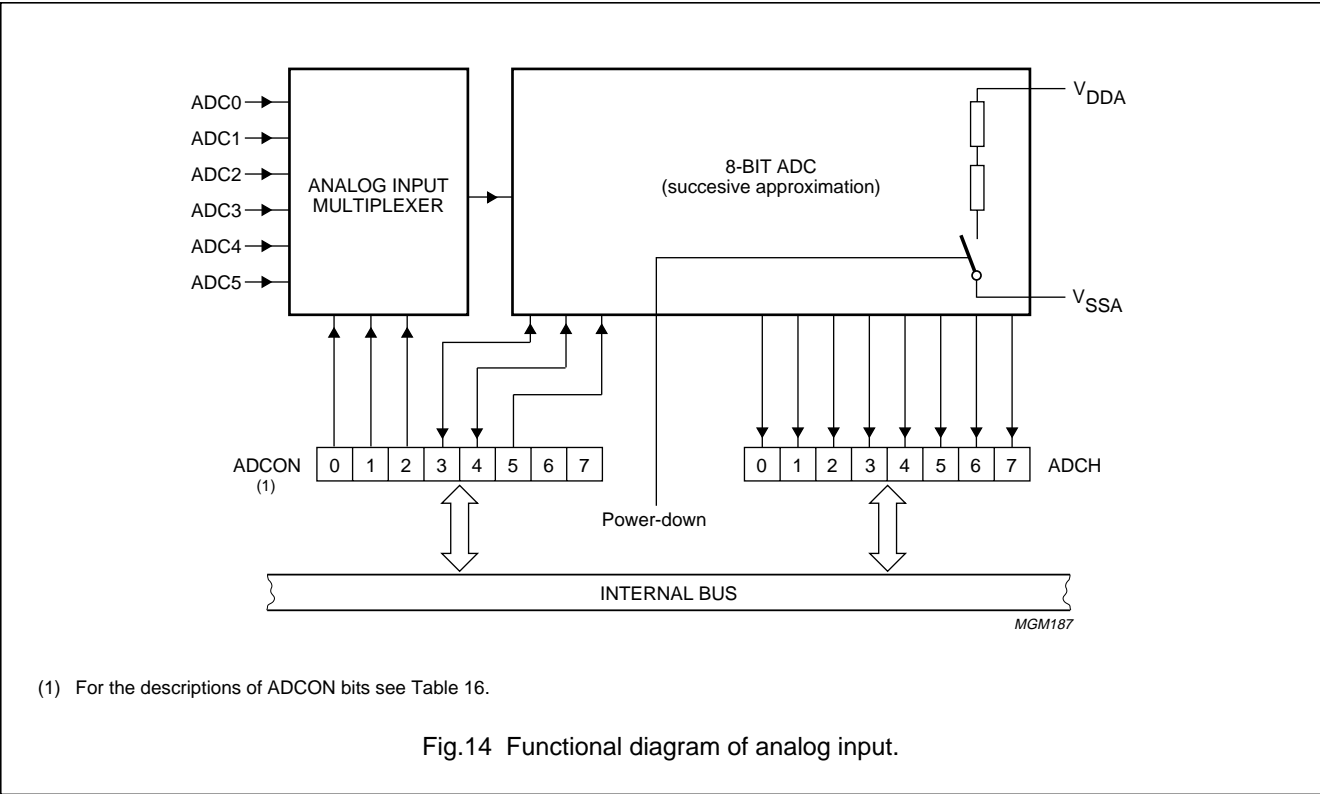
To save power the ADC current is switched on only during conversion and is independent of the processor mode (active, Idle or Power-down). If the processor goes into Idle or Power-down mode, the ADC interrupt must be used to wake-up the CPU again.

While $ADCS = 1$ or $ADIF = 1$, a new ADC start will be blocked and consequently lost, however an ADC conversion already in progress will finish uninterrupted. An ADC conversion already in progress is aborted when the Power-down mode is entered. The result of a completed conversion ($ADIF = 1$) remains unaffected when entering the Idle or Power-down mode.

When no result of a completed conversion ($ADIF = 0$) is available, the ADCON and ADCH registers will be reset when entering the Power-down mode. Note that $AADRx$ and $CKDIV$ have to be set explicitly to restore their previous values for the first conversion after Power-down mode.

Table 14 Conversion time in clock cycles

CONDITION	MAX.	REMARK
$f_{clk} \leq 8\text{ MHz}$, $CKDIV = 0$	288	normal conversion
$f_{clk} > 8\text{ MHz}$, $CKDIV = 1$	576	prescaler used



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14.1 ADC Control Register (ADCON)

Table 15 ADC Control Register (SFR address C4H)

7	6	5	4	3	2	1	0
–	–	CKDIV	ADCI	ADCS	AADR2	AADR1	AADR0

Table 16 Description of ADCON bits

BIT	SYMBOL	DESCRIPTION
7	–	These 2 bits are reserved.
6	–	
5	CKDIV	Prescaler select. When CKDIV = 1, the ADC clock prescaler is used (divide-by-2). Prescaling is necessary with clocks over 8 MHz.
4	ADCI	ADC interrupt flag. This flag is set when an ADC conversion result is ready to be read. An interrupt is invoked if this is enabled (EAD). This flag must be cleared by software, (it cannot be set by software).
3	ADCS	ADC start and status flag. When this bit is set an ADC conversion is started. ADCS must be set by software. The ADC logic ensures that this signal is HIGH while the ADC is busy. On completion of the conversion ADCI is set and one clock later the ADCS flag is reset. ADCS cannot be reset by software.
2	AADR2	Analog input select. These bits are used to select one of the six analog inputs; see Table 17.
1	AADR1	
0	AADR0	

Table 17 Selection of analog input channel

AADR2	AADR1	AADR0	SELECTED CHANNEL
0	0	0	ADC0
0	0	1	ADC1
0	1	0	ADC2
0	1	1	ADC3
1	0	0	ADC4
1	0	1	ADC5
1	1	0	reserved
1	1	1	reserved

14.2 ADC Result Register (ADCH)

Table 18 ADC Result Register (SFR address C5H)

7	6	5	4	3	2	1	0
ADC7	ADC6	ADC5	ADC4	ADC3	ADC2	ADC1	ADC0

Table 19 Description of ADCH bits

BIT	SYMBOL	DESCRIPTION
7 to 0	ADC7 to ADC0	8-bit ADC result

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15 REDUCED POWER MODES

There are two software selectable modes of reduced activity for further power reduction: Idle and Power-down.

15.1 Idle mode

Idle mode operation permits the interrupt, serial ports, timer blocks, PWM and ADC to continue to function while the clock to the CPU is halted.

The following functions remain active during the Idle mode:

- Timer 0, Timer 1, Timer 2 and Timer 3 (Watchdog Timer)
- UART, I²C-bus interface
- Internal interrupt
- External interrupt
- PWM
- ADC.

These functions may generate an interrupt or reset; thus ending the Idle mode.

The instruction that sets bit IDL (PCON.0) is the last instruction executed in the normal operating mode before the Idle mode is activated. Once in Idle mode, the CPU status is preserved along with the Stack Pointer, Program Counter, Program Status Word, SFRs and Accumulator. The RAM and all other registers maintain their data during Idle mode. The status of the external pins during Idle mode is shown in Table 20.

15.1.1 TERMINATION OF THE IDLE MODE USING AN ENABLED INTERRUPT

Activation of any enabled interrupt will cause IDL (PCON.0) to be cleared by hardware thus terminating the Idle mode. The interrupt is serviced, and following the RETI instruction, the next instruction to be executed will be the one following the instruction that put the device in the Idle mode. The flag bits GF0 (PCON.2) and GF1 (PCON.3) may be used to determine whether the interrupt was received during normal execution or during the Idle mode.

For example, the instruction that writes to PCON.0 can also set or clear one or both flag bits. When the Idle mode is terminated by an interrupt, the service routine can examine the status of the flag bits.

15.1.2 TERMINATION OF THE IDLE MODE USING AN EXTERNAL HARDWARE RESET

The second way of terminating the Idle mode is with an external hardware reset, or an internal reset caused by an overflow of Timer 3 (Watchdog Timer). Since the clock is still running, the hardware reset is required to be active for two machine cycles (12 clock periods) to complete the reset operation. Reset redefines all SFRs but does not affect the on-chip RAM.

15.2 Power-down mode

The Power-down operation freezes the SZF2002. The Power-down mode can only be activated by setting the PD bit in the PCON register.

The instruction that sets PD (PCON.1) is the last executed prior to going into the Power-down mode. Once in the Power-down mode, the internal clock is stopped. The contents of the on-chip RAM and the SFRs are preserved. The port pins output the value held by their respective SFRs. OE is held HIGH, but CE is switched to HIGH, so the external ROM will not be enabled during power down, to save system power.

15.3 Wake-up from Power-down mode

Setting the PD flag in the PCON register forces the controller into the Power-down mode. Setting this flag enables the controller to be woken-up from the Power-down mode with either the external interrupts INT0 to INT8, or a reset operation. The wake-up operation has two basic approaches as explained in Section 15.3.1 and 15.3.2.

15.3.1 WAKE-UP USING $\overline{\text{INT0}}$ TO $\overline{\text{INT8}}$

If any of the interrupts $\overline{\text{INT0}}$ to $\overline{\text{INT8}}$ is enabled, the device can be woken-up from the Power-down mode with these external interrupts. The user must ensure that the external clock is stable before the controller restarts, the internal clock will remain inactive for 18 clock periods. This is controlled by an on-chip delay counter.

15.3.2 WAKE-UP USING RST

To wake-up the SZF2002, the RST pin must be kept HIGH for a minimum of 12 clock cycles. The user must ensure that the external clock is stable before the controller restarts (at RST falling edge), the internal clock will remain inactive for 18 clock periods. This is controlled by an on-chip delay counter.

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15.4 Status of external pins

The status of the external pins during Idle and Power-down mode is shown in Table 20.

Table 20 Status of external pins during Idle and Power-down modes

MODE	MEMORY	$\overline{\text{CE}}$	$\overline{\text{OE}}$	PWM	PORTS 1, 3 AND 4	DATA BUS
Idle	internal	1	1	active	port data	Port 0 data
	external	1	1	active	port data	floating
Power-down	internal	1	1	halted in last state	port data	Port 0 data
	external	1	1	halted in last state	port data	floating

15.5 Power Control Register (PCON)

Idle and Power-down modes are activated by software using this SFR. PCON is not bit addressed, the reset value of PCON is 00000000B.

Table 21 Power Control Register (SFR address 87H)

7	6	5	4	3	2	1	0
SMOD	ARD	RFI	WLE	GF1	GF0	PD	IDL

Table 22 Description of PCON bits

BIT	SYMBOL	DESCRIPTION
7	SMOD	Double Baud rate. When set to a logic 1 the baud rate is doubled when the serial port SIO0 is being used in modes 1, 2 or 3 (except when Timer 2 is used).
6	ARD	Setting this bit will force all MOVX instructions to access off-chip memory instead of AUX RAM.
5	RFI	RFI reduction mode. Setting this bit will disable the ALE toggling during on-chip memory access. The SZF2002 does not have this signal during operational mode, but setting this bit will reduce the number of chip selects ($\overline{\text{CE}}$) of the external memory (and thus power).
4	WLE	Watchdog Load Enable. This flag must be set by software prior to loading the Watchdog Timer (T3). It is cleared when T3 is loaded.
3	GF1	General purpose flag 1.
2	GF0	General purpose flag 0.
1	PD	Power-down mode selection. Setting this bit activates the Power-down mode. If a logic 1 is written to both PD and IDL at the same time, PD takes precedence.
0	IDL	Idle mode selection. Setting this bit activates the Idle mode.

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16 I²C-BUS SERIAL I/O

The serial port supports the twin line I²C-bus, which consists of a data line (SDA) and a clock line (SCL). These lines also function as the I/O port lines P1.7 and P1.6 respectively.

The system is unique because data transport, clock generation, address recognition and bus control arbitration are all controlled by hardware.

The I²C-bus serial I/O has complete autonomy in byte handling and operates in 4 modes:

- Master transmitter
- Master receiver
- Slave transmitter
- Slave receiver.

These functions are controlled by the Serial Control Register (S1CON). S1STA is the Status Register whose contents may also be used as a vector to various service routines. S1DAT is the Data Shift Register and S1ADR is the Slave Address Register. Slave address recognition is performed by on-chip hardware.

Figure 15 shows the block diagram of the I²C-bus serial I/O.

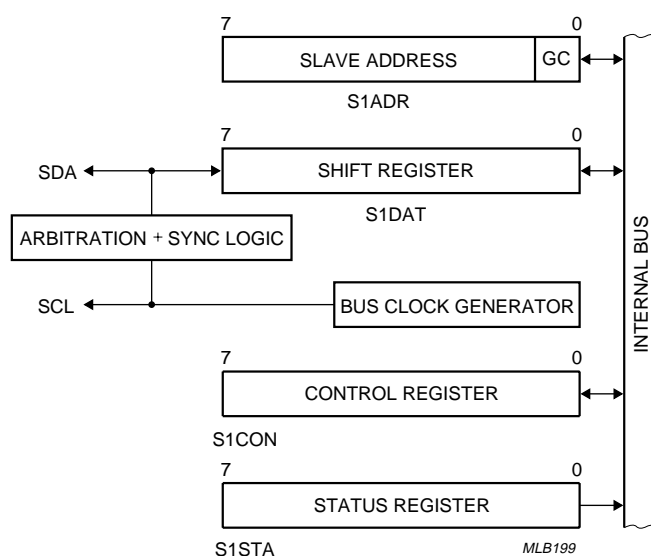


Fig.15 Block diagram of I²C-bus serial I/O.

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16.1 Serial Control Register (S1CON)

Table 23 Serial Control Register (SFR address D8H)

7	6	5	4	3	2	1	0
CR2	ENS1	STA	STO	SI	AA	CR1	CR0

Table 24 Description of S1CON bits

BIT	SYMBOL	DESCRIPTION
6	ENS1	Enable serial I/O. When ENS1 = 0, the serial I/O is disabled. SDA and SCL outputs are in the high-impedance state; P1.6 and P1.7 function as open-drain ports. When ENS1 = 1, the serial I/O is enabled. Output port latches P1.6 and P1.7 must be set to logic 1.
5	STA	START flag. When this bit is set in Slave mode, the SIO hardware checks the status of the I ² C-bus and generates a START condition if the bus is free or after the bus becomes free. If STA is set while the SIO is in Master mode, SIO will generate a repeated START condition.
4	STO	STOP flag. With this bit set while in Master mode a STOP condition is generated. When a STOP condition is detected on the I ² C-bus, the SIO hardware clears the STO flag. STO may also be set in Slave mode in order to recover from an error condition. In this case no STOP condition is transmitted to the I ² C-bus. However, the SIO hardware behaves as if a STOP condition has been received and releases the SDA and SCL lines. The SIO then switches to the not addressed Slave receiver mode. The STOP flag is cleared by the hardware.
3	SI	SIO interrupt flag. This flag is set and an interrupt is generated, after any of the following events occur: <ul style="list-style-type: none"> • A START condition is generated in Master mode • Own slave address has been received during AA = 1 • The general call address has been received while GC (S1ADR.0) = 1 and AA = 1 • A data byte has been received or transmitted in Master mode (even if arbitration is lost) • A data byte has been received or transmitted as selected slave • A STOP or START condition is received as selected slave receiver or transmitter.
2	AA	Assert Acknowledge. When this bit is set, an acknowledge (LOW level to SDA) is returned during the acknowledge clock pulse on the SCL line when: <ul style="list-style-type: none"> • Own slave address is received • General call address is received; GC (S1ADR.0) = 1 • A data byte is received while the device is programmed to be a Master receiver • A data byte is received while the device is a selected Slave receiver. When this bit is reset, no acknowledge is returned. Consequently, no interrupt is requested when the own slave address or general call address is received.
7	CR2	Clock Rate selection. These 3 bits determine the serial clock frequency when SIO is in the Master mode. See Table 25.
1	CR1	
0	CR0	

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Table 25 Selection of the serial clock frequency (SCL) in a Master mode of operation

CR2	CR1	CR0	f_{clk} DIVISOR	BIT RATE (kHz) AT $f_{\text{clk}} = 1 \text{ MHz}$
0	0	0	128	7.81
0	0	1	112	8.93
0	1	0	96	10.42
0	1	1	80	12.50
1	0	0	480	2.08
1	0	1	60	16.67
1	1	0	30	33.33
1	1	1	reserved	–

16.2 Serial Status Register (S1STA)

S1STA is a read-only register. The contents of this register may be used as a vector to a service routine. This optimizes the response time of the software and consequently that of the I²C-bus. The status codes for all possible modes of the I²C-bus interface is given in Table 29. The register has only a valid vector to a service routine if the SI bit of the S1CON register is set, otherwise it is invalid, usually F8H.

Table 26 Serial Status Register (SFR address D9H)

7	6	5	4	3	2	1	0
SC4	SC3	SC2	SC1	SC0	0	0	0

Table 27 Description of S1STA bits

BIT	SYMBOL	DESCRIPTION
3 to 7	SC4 to SC0	5-bit status code; see Table 29.
0 to 2	–	These three bits are always zero.

Table 28 Symbols used in Table 29

SYMBOL	DESCRIPTION
SLA	7-bit slave address
R	read bit
W	write bit
ACK	acknowledgement (acknowledge bit is logic 0)
$\overline{\text{ACK}}$	no acknowledgement (acknowledge bit is logic 1)
DATA	data byte to or from I ² C-bus
MST	master
SLV	slave
TRX	transmitter
REC	receiver

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Table 29 Status codes

S1STA VALUE	DESCRIPTION
MST/TRX mode	
08H	A START condition has been transmitted.
10H	A repeated START condition has been transmitted.
18H	SLA and W have been transmitted, ACK has been received.
20H	SLA and W have been transmitted, $\overline{\text{ACK}}$ received.
28H	DATA of S1DAT has been transmitted, ACK received.
30H	DATA of S1DAT has been transmitted, $\overline{\text{ACK}}$ received.
38H	Arbitration lost in SLA, R/W or DATA.
MST/REC mode	
08H	A START condition has been transmitted.
10H	A repeated START condition has been transmitted.
38H	Arbitration lost while returning $\overline{\text{ACK}}$.
40H	SLA and R have been transmitted, ACK received.
48H	SLA and R have been transmitted, $\overline{\text{ACK}}$ received.
50H	DATA has been received, ACK returned.
58H	DATA has been received, $\overline{\text{ACK}}$ returned.
SLV/REC mode	
60H	Own SLA and W have been received, ACK returned.
68H	Arbitration lost in SLA, R/W as MST. Own SLA and W have been received, ACK returned.
70H	General CALL has been received, ACK returned.
78H	Arbitration lost in SLA, R/W as MST. General CALL has been received.
80H	Previously addressed with own SLA. DATA byte received, ACK returned.
88H	Previously addressed with own SLA. DATA byte received, $\overline{\text{ACK}}$ returned.
90H	Previously addressed with general CALL. DATA byte has been received, ACK has been returned.
98H	Previously addressed with general CALL. DATA byte has been received, $\overline{\text{ACK}}$ has been returned.
A0H	A STOP condition or repeated START condition has been received while still addressed as SLV/REC or SLV/TRX.
SLV/TRX mode	
A8H	Own SLA and R have been received, ACK returned.
B0H	Arbitration lost in SLA and R/W as MST. Own SLA and R have been received, ACK returned.
B8H	DATA byte has been transmitted, ACK received.
C0H	DATA byte has been transmitted, $\overline{\text{ACK}}$ received.
C8H	Last DATA byte has been transmitted (AA = 0), ACK received.
Miscellaneous	
00H	Bus error during MST mode or selected SLV mode, due to an erroneous START or STOP condition.
F8H	No relevant state information available, SI = 0.

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16.3 Data Shift Register (S1DAT)

S1DAT contains the serial data to be transmitted or data which has just been received. The MSB (bit 7) is transmitted or received first; i.e. data shifted from right to left. The data received is only valid while the SI bit of the S1CON register is set.

Table 30 Data Shift Register (SFR address DAH)

7	6	5	4	3	2	1	0
S1DAT.7	S1DAT.6	S1DAT.5	S1DAT.4	S1DAT.3	S1DAT.2	S1DAT.1	S1DAT.0

16.4 Address Register (S1ADR)

This 8-bit register may be loaded with the 7-bit slave address to which the controller will respond when programmed as a slave receiver/transmitter.

Table 31 Address Register (SFR address DBH)

7	6	5	4	3	2	1	0
SLA6	SLA5	SLA4	SLA3	SLA2	SLA1	SLA0	GC

Table 32 Description of S1ADR bits

BITS	SYMBOL	DESCRIPTION
7 to 1	SLA6 to SLA0	Own slave address.
0	GC	This bit is used to determine whether the general call address is recognized. When GC = 0, the general call address is not recognized; when GC = 1, the general call address is recognized.

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17 STANDARD SERIAL INTERFACE SIO0: UART

This serial port is full duplex which means that it can transmit and receive simultaneously. It is also receive-buffered and can commence reception of a second byte before a previously received byte has been read from the register. (However, if the first byte has not been read by the time the reception of the second byte is complete, one of the bytes will be lost). The serial port receive and transmit registers are both accessed via the Special Function Register S0BUF. Writing to S0BUF loads the transmit register and reading S0BUF accesses a physically separate receive register.

The serial port can operate in 4 modes:

- Mode 0 Serial data enters and exits through RXD. TXD outputs the shift clock. 8 bits are transmitted/received (LSB first). The baud rate is fixed at $\frac{1}{6}f_{clk}$. See Figs 17 and 18.
- Mode 1 10 bits are transmitted (through TXD) or received (through RXD): a start bit (logic 0), 8 data bits (LSB first), and a stop bit (logic 1). On receive, the stop bit goes into RB8 in the SFR S0CON. The baud rate is variable. See Figs 19 and 20.
- Mode 2 11 bits are transmitted (through TXD) or received (through RXD): start bit (logic 0), 8 data bits (LSB first), a programmable 9th data bit, and a stop bit (logic 1). On transmit, the 9th data bit (TB8 in S0CON) can be assigned the value of a logic 0 or logic 1. Or, for example, the parity bit (P, in the PSW) could be moved into TB8. On receive, the 9th data bit goes into RB8 in S0CON, while the stop bit is ignored. The baud rate is programmable to either $\frac{1}{16}$ or $\frac{1}{32}f_{clk}$. See Figs 21 and 22.
- Mode 3 11 bits are transmitted (through TXD) or received (through RXD): a start bit (logic 0), 8 data bits (LSB first), a programmable 9th data bit and a stop bit (logic 1). In fact, Mode 3 is the same as Mode 2 in all respects except baud rate. The baud rate in Mode 3 is variable. See Figs 23 and 24.

In all four modes, transmission is initiated by any instruction that uses S0BUF as a destination register. Reception is initiated in Mode 0 by the condition $RI = 0$ and $REN = 1$. Reception is initiated in the other modes by the incoming start bit if $REN = 1$.

17.1 Multiprocessor communications

Modes 2 and 3 have a special provision for multiprocessor communications. In these modes, 9 data bits are received. The 9th bit goes into RB8. The following bit is the stop bit. The port can be programmed such that when the stop bit is received, the serial port interrupt will be activated, but only if $RB8 = 1$. This feature is enabled by setting bit SM2 in S0CON. One use of this feature, in multiprocessor systems, is as follows.

When the master processor wants to transmit a block of data to one of several slaves, it first sends out an address byte which identifies the target slave. An address byte differs from a data byte in that the 9th bit is HIGH in an address byte and LOW in a data byte. With $SM2 = 1$, no slave will be interrupted by a data byte. An address byte, however, will interrupt all slaves, so that each slave can examine the received byte and see if it is being addressed. The addressed slave will clear its SM2 bit and prepare to receive the data bytes that will be sent. The slaves that were not being addressed leave their SM2 bits set and go on about their business, ignoring the coming data bytes.

SM2 has no effect in Mode 0, and in Mode 1 can be used to check the validity of the stop bit. In a Mode 1 reception, if $SM2 = 1$, the receive interrupt will not be activated unless a valid stop bit is received.

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17.2 Serial Port Control and Status Register (S0CON)

The Serial Port Control and Status Register is the Special Function Register S0CON. The register contains not only the mode selection bits, but also the 9th data bit for transmit and receive (TB8 and RB8), and the serial port interrupt bits (TI and RI).

Table 33 Serial Port Control Register (SFR address 98H)

7	6	5	4	3	2	1	0
SMO	SM1	SM2	REN	TB8	RB8	TI	RI

Table 34 Description of S0CON bits

BIT	SYMBOL	DESCRIPTION
7	SM0	Mode select. These 2 bits are used to select the serial port mode; see Table 35.
6	SM1	
5	SM2	Enables the multiprocessor communication feature in Modes 2 and 3. In these modes, if SM2 = 1, then RI will not be activated if the received 9th data bit (RB8) is a logic 0. In Mode 1, if SM2 = 1, then RI will not be activated unless a valid stop bit was received. In Mode 0, SM2 should be a logic 0.
4	REN	Enable serial reception. REN is set by software to enable reception, and cleared by software to disable reception.
3	TB8	Is the 9th data bit that will be transmitted in Modes 2 and 3. Set or cleared by software as desired.
2	RB8	In Modes 2 and 3, is the 9th data bit received. In Mode 1, if SM2 = 0, then RB8 is the stop bit that was received. In Mode 0, RB8 is not used.
1	TI	Transmit interrupt flag. Set by hardware at the end of the 8th bit time in Mode 0, or at the beginning of the stop bit time in the other modes, in any serial transmission. Must be cleared by software.
0	RI	Receive interrupt flag. Set by hardware at the end of the 8th bit time in Mode 0, or halfway through the stop bit time in the other modes, in any serial transmission (except see SM2). Must be cleared by software.

Table 35 Selection of the serial port modes

SMO	SM1	MODE	DESCRIPTION	BAUD RATE
0	0	Mode 0	shift register	$\frac{1}{6}f_{clk}$
0	1	Mode 1	8-bit UART	variable
1	0	Mode 2	9-bit UART	$\frac{1}{16}f_{clk}$ or $\frac{1}{32}f_{clk}$
1	1	Mode 3	9-bit UART	variable

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17.3 Baud rates

The baud rate in Mode 0 is fixed and may be calculated as:

$$\text{Baud rate} = \frac{f_{\text{clk}}}{6}$$

The baud rate in Mode 2 depends on the value of the SMOD bit in Special Function Register PCON and may be calculated as:

$$\text{Baud rate} = \frac{2^{\text{SMOD}}}{32} \times f_{\text{clk}}$$

- If SMOD = 0 (value on reset), the baud rate is $\frac{1}{32}f_{\text{clk}}$
- If SMOD = 1, the baud rate is $\frac{1}{16}f_{\text{clk}}$.

17.3.1 USING TIMER 1 TO GENERATE BAUD RATES

When Timer 1 is used as the Baud Rate Generator, the baud rates in Modes 1 and 3 are determined by the Timer 1 overflow rate and the value of the SMOD bit as follows:

$$\text{Baud rate} = \frac{2^{\text{SMOD}}}{32} \times \text{Timer 1 overflow rate}$$

The Timer 1 interrupt should be disabled in this application. The timer itself can be configured for either 'timer' or 'counter' operation in any of its 3 running modes. In typical applications, it is configured for 'timer' operation, in the Auto-reload mode (high nibble of TMOD = 0010B). In this case the baud rate is given by:

$$\text{Baud rate} = \frac{2^{\text{SMOD}}}{32} \times \frac{f_{\text{clk}}}{\{6 \times (256 - \text{TH1})\}}$$

By configuring Timer 1 to run as a 16-bit timer (high nibble of TMOD = 0001B), and using the Timer 1 interrupt to do a 16-bit software reload, very low baud rates can be achieved.

17.3.2 USING TIMER 2 TO GENERATE BAUD RATES

Timer 2 is selected as a Baud Rate Generator by setting the RCLK0, TCLK0, RCLK1, or TCLK1 bit in T2CON. The Baud Rate Generator mode is similar to the Auto-reload mode, in that a roll-over in TH2 causes Timer 2 registers to be reloaded with the 16-bit value held in the registers RCAP2H and RCAP2L, which are preset by software.

Baud rates in Modes 1 and 3 are determined by Timer 2's overflow rate as specified below:

$$\text{Baud rate} = \frac{\text{Timer 2 overflow rate}}{16}$$

Timer 2 can be configured for either 'timer' or 'counter' operation. In the most typical applications, it is configured for 'timer' operation (C/T2 = 0). 'Timer' operation is slightly different for Timer 2 when it is being used as a Baud Rate Generator. Normally, as a timer it would increment every machine cycle at a frequency of $\frac{1}{6}f_{\text{clk}}$. However, as a Baud Rate Generator it increments every state time at a frequency of f_{clk} . In this case, the baud rate in Modes 1 and 3 is determined as shown by the following equation:

$$\text{Baud rate} = \frac{f_{\text{clk}}}{16 \times \{65536 - (\text{RCAP2H}; \text{RCAP2L})\}}$$

Where (RCAP2H; RCAP2L) is the content of registers RCAP2H and RCAP2L taken as a 16-bit unsigned integer.

Note that the maximum baud rate depends on clock frequency and is determined by the following equation:

$$\text{Maximum baud rate} = \frac{f_{\text{clk}}}{16 \times 6}$$

The Baud Rate Generator mode for Timer 2 is shown in Fig.16. This figure is only valid if RCLK0 = 1 or TCLK0 = 1 or RCLK1 = 1 or TCLK1 = 1. At roll-over TH2 does not set the TF2 bit in T2CON and therefore, will not generate an interrupt. Consequently, the Timer 2 interrupt does not need to be disabled when in the Baud Rate Generator mode. If EXEN2 is set, a HIGH-to-LOW transition on T2EX will set the EXF2 bit, also in T2CON, but will not cause a reload from (RCAP2H; RCAP2L) to (TH2 and TL2). Therefore, in this mode T2EX may be used as an additional external interrupt.

When Timer 2 is operating as a timer (TR2 = 1), in the Baud Rate Generator mode, registers TH2 and TL2 should not be accessed (read or write). Under these conditions the timer increments every state time and therefore the results of a read or write may not be accurate. The registers RCAP2H and RCAP2L however, may be read but not written to. A write might overlap a reload and cause write and/or reload errors. If a write operation is required, Timer 2 or RCAP2H/RCAP2L should first be turned off by clearing the TR2 bit.

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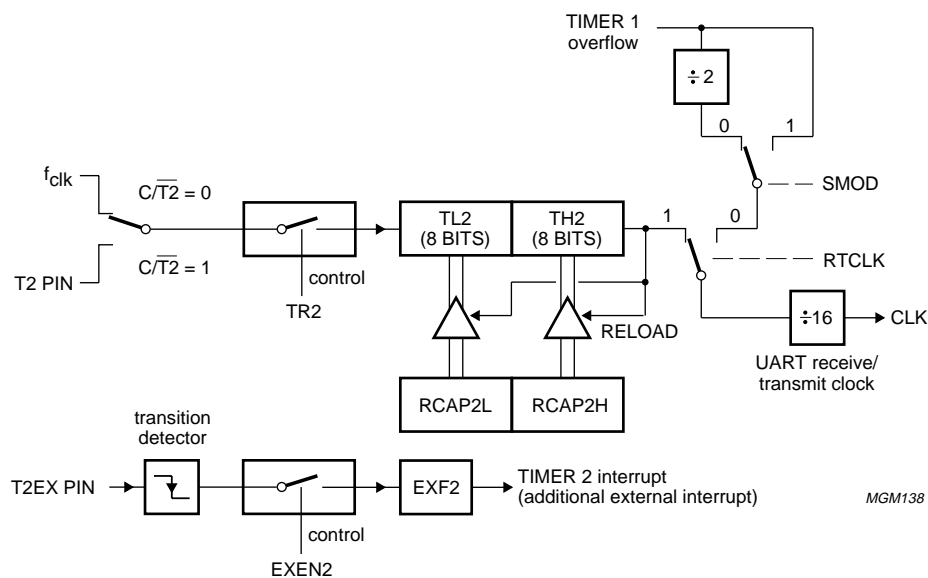


Fig.16 Timer 2 in Baud Rate Generator mode.

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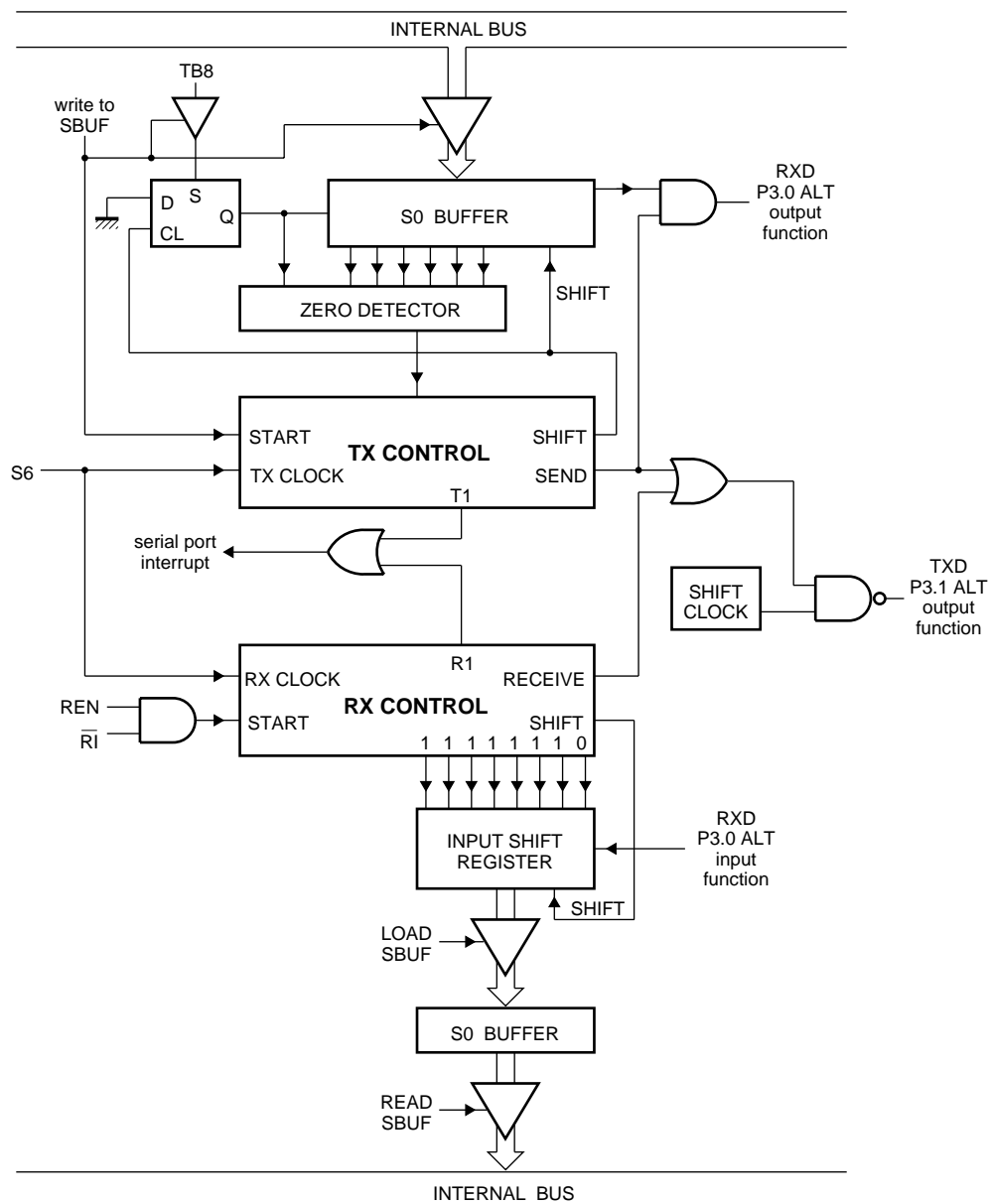


Fig.17 Serial port Mode 0.

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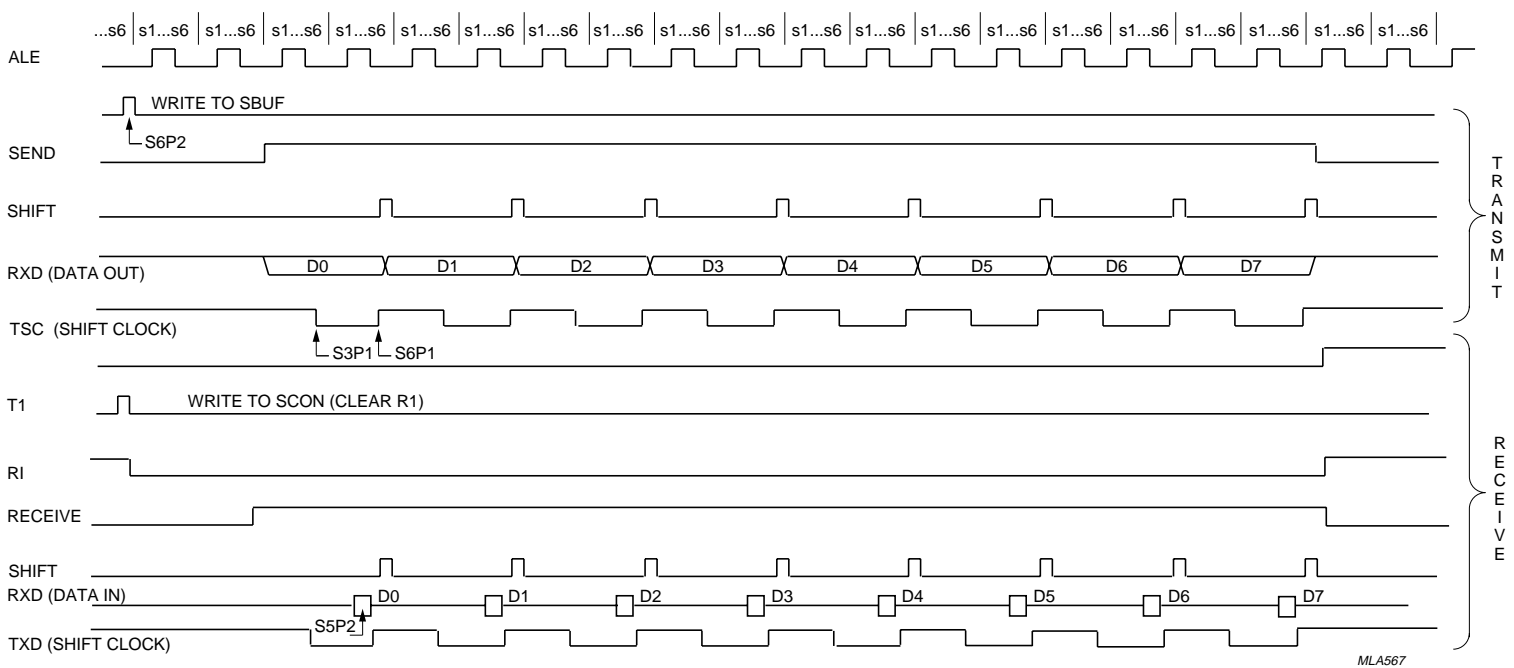


Fig.18 Serial port Mode 0 timing.

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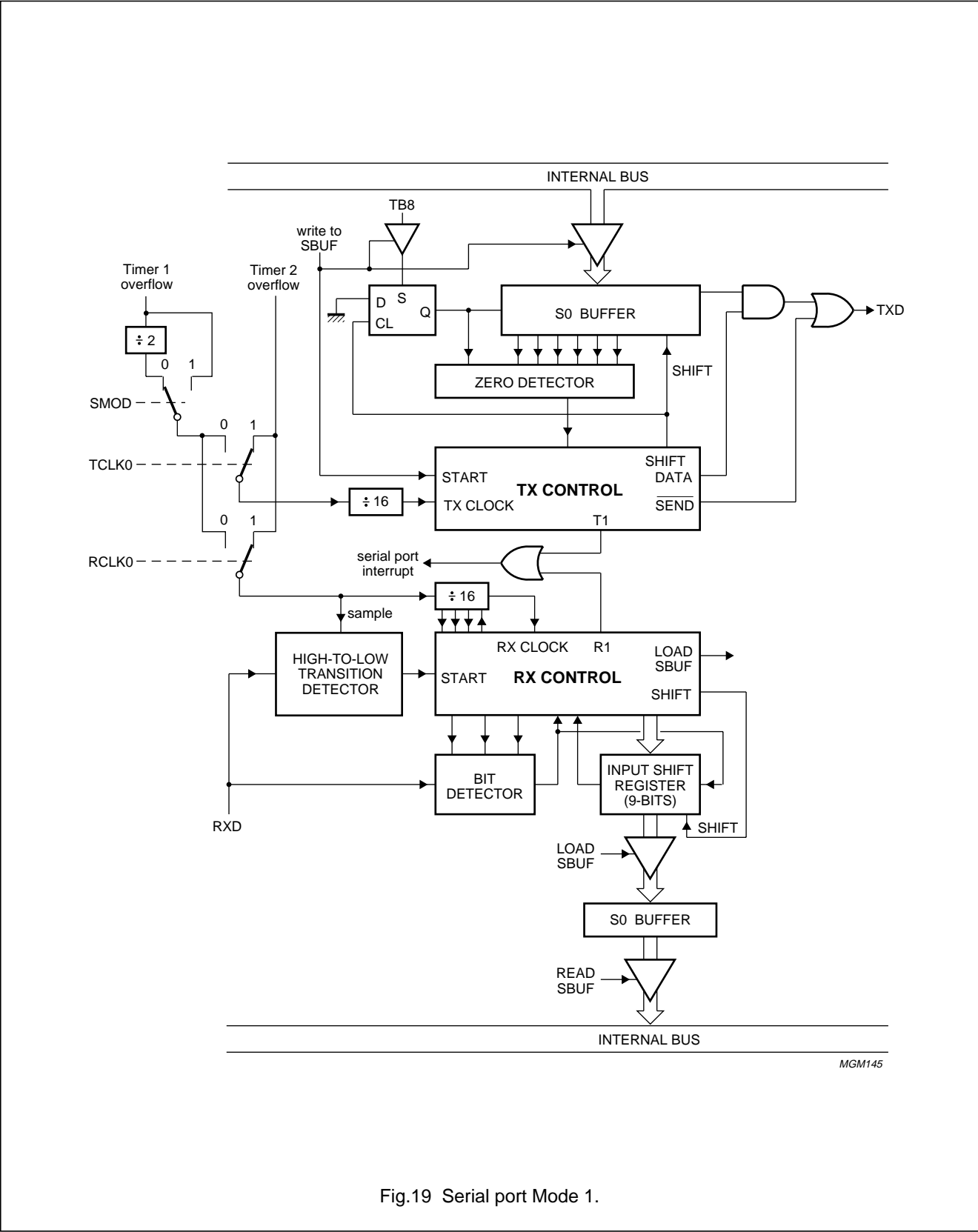


Fig.19 Serial port Mode 1.

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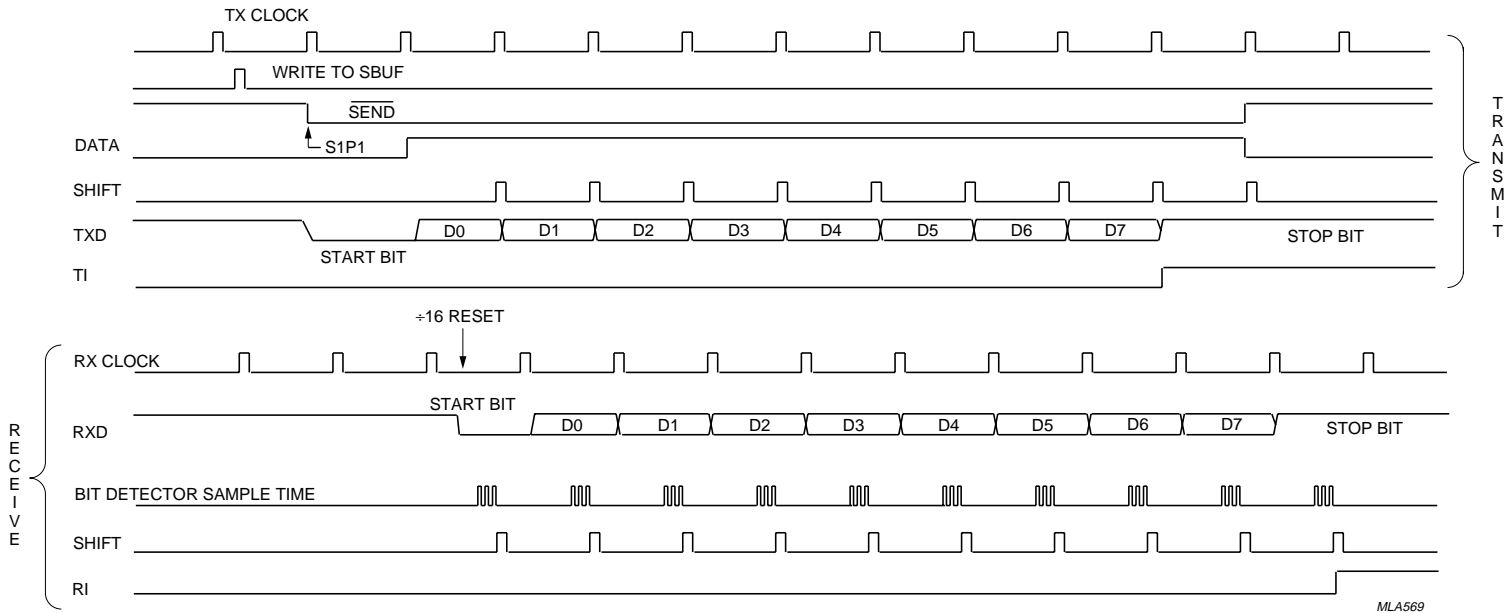


Fig.20 Serial port Mode 1 timing.

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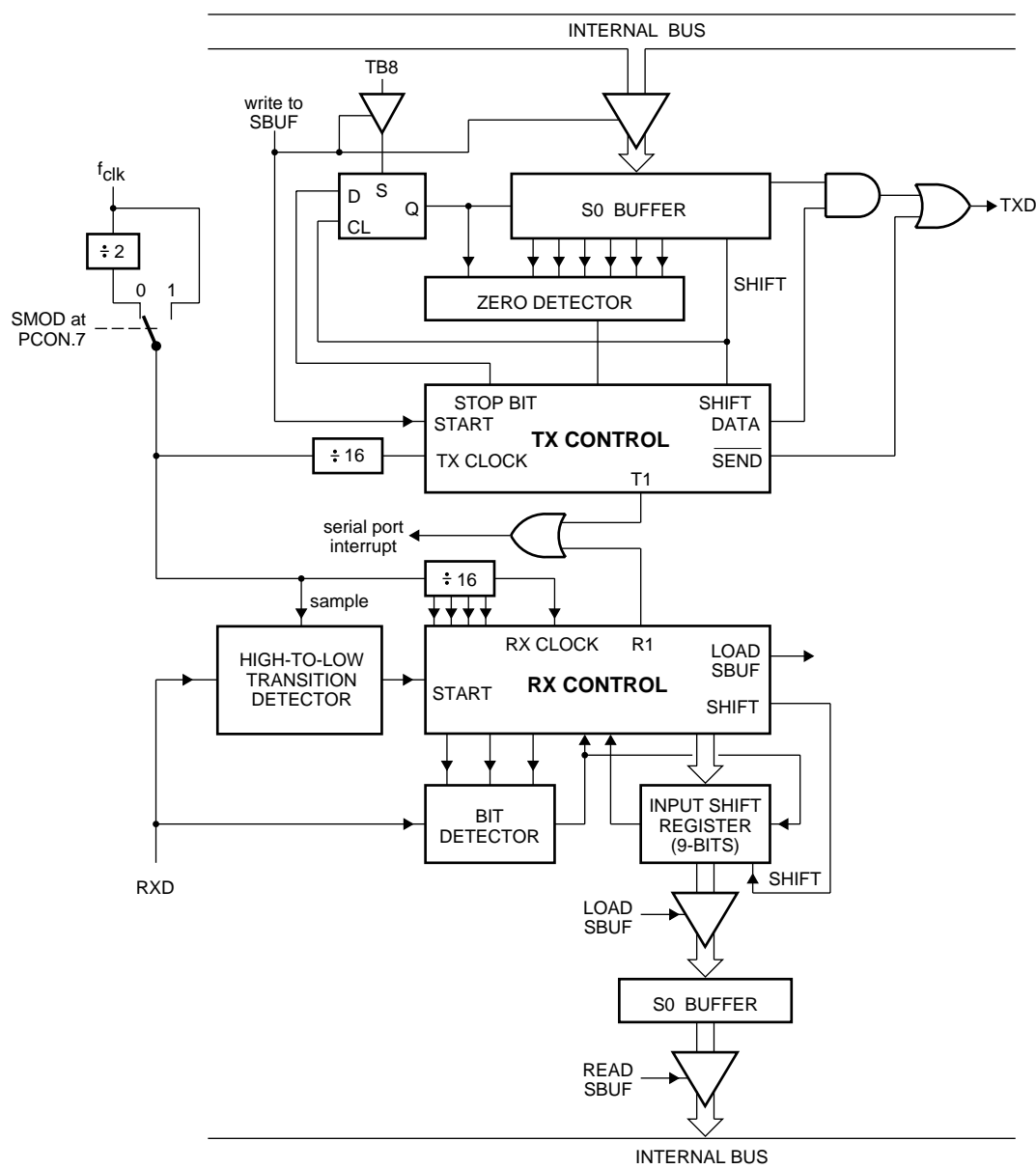


Fig.21 Serial port Mode 2.

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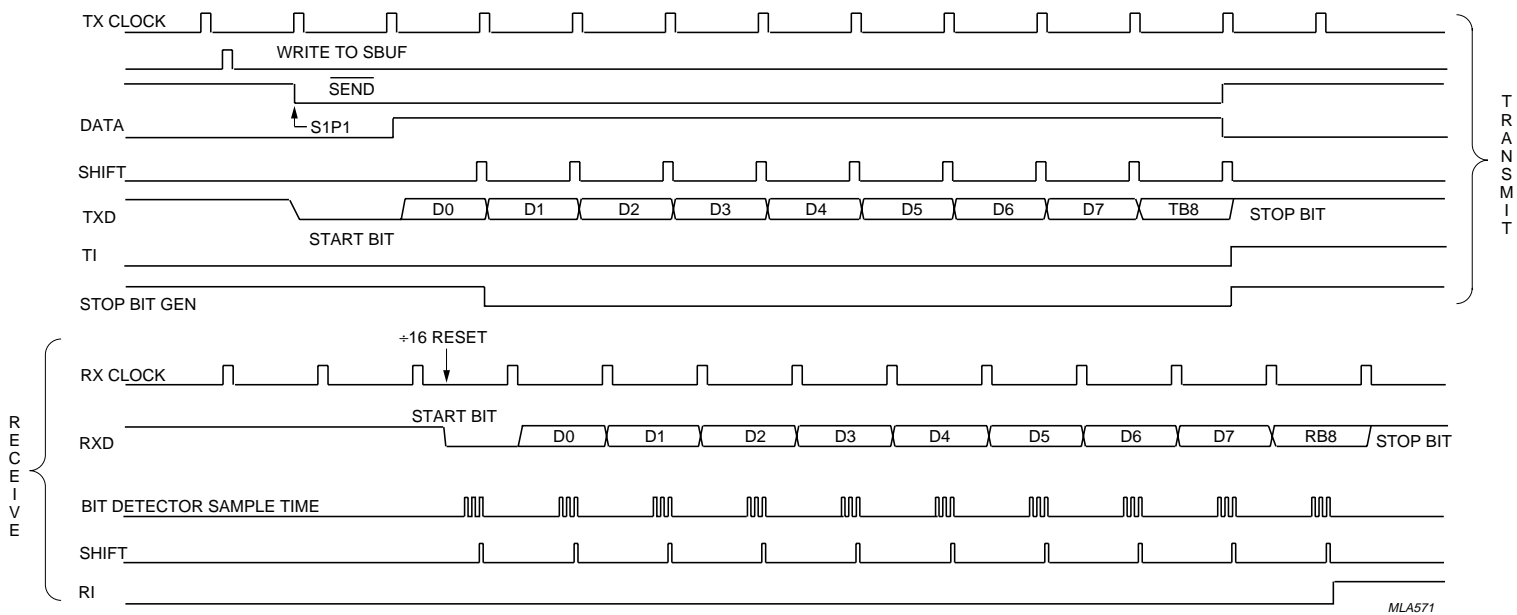


Fig.22 Serial port Mode 2 timing.

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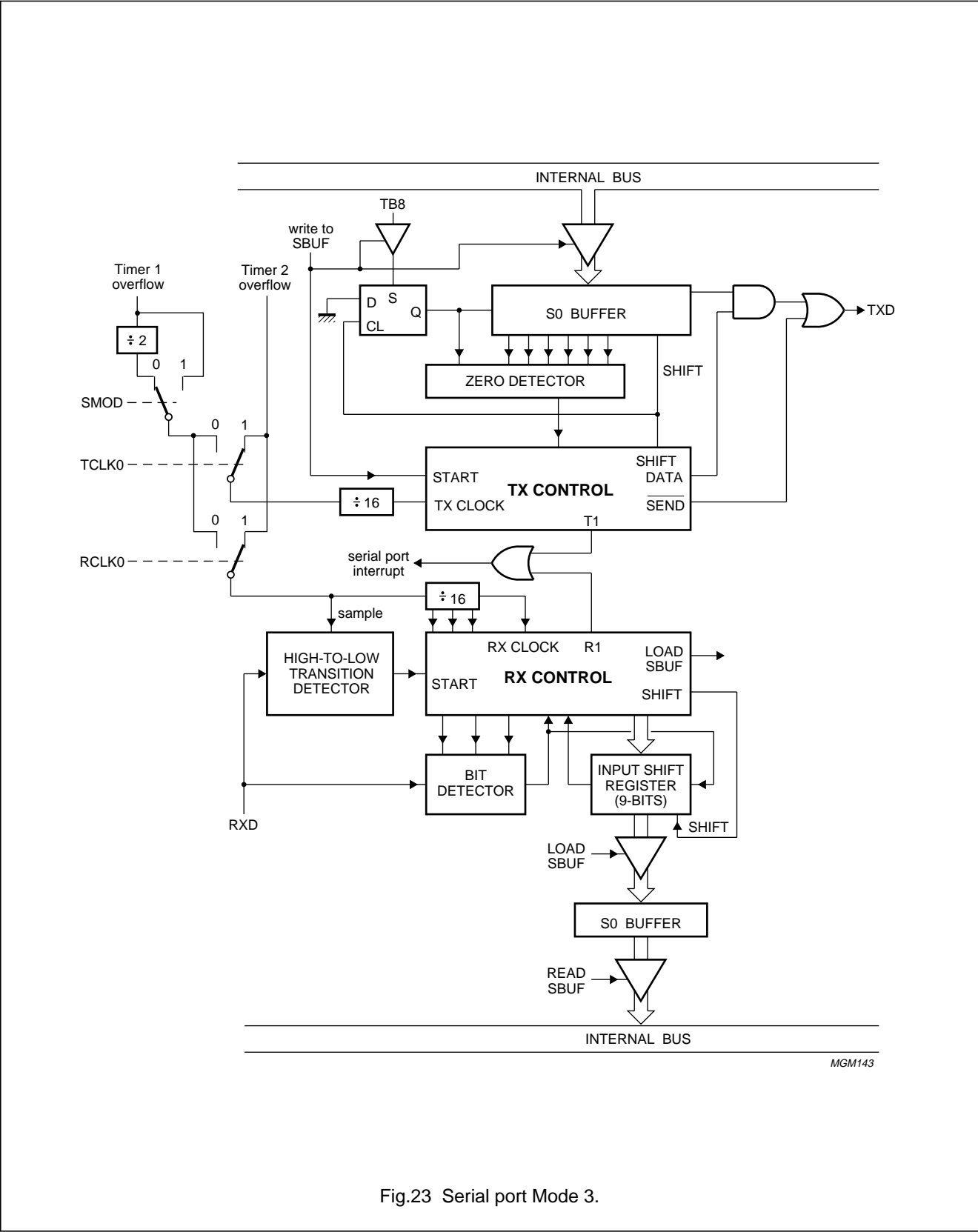


Fig.23 Serial port Mode 3.

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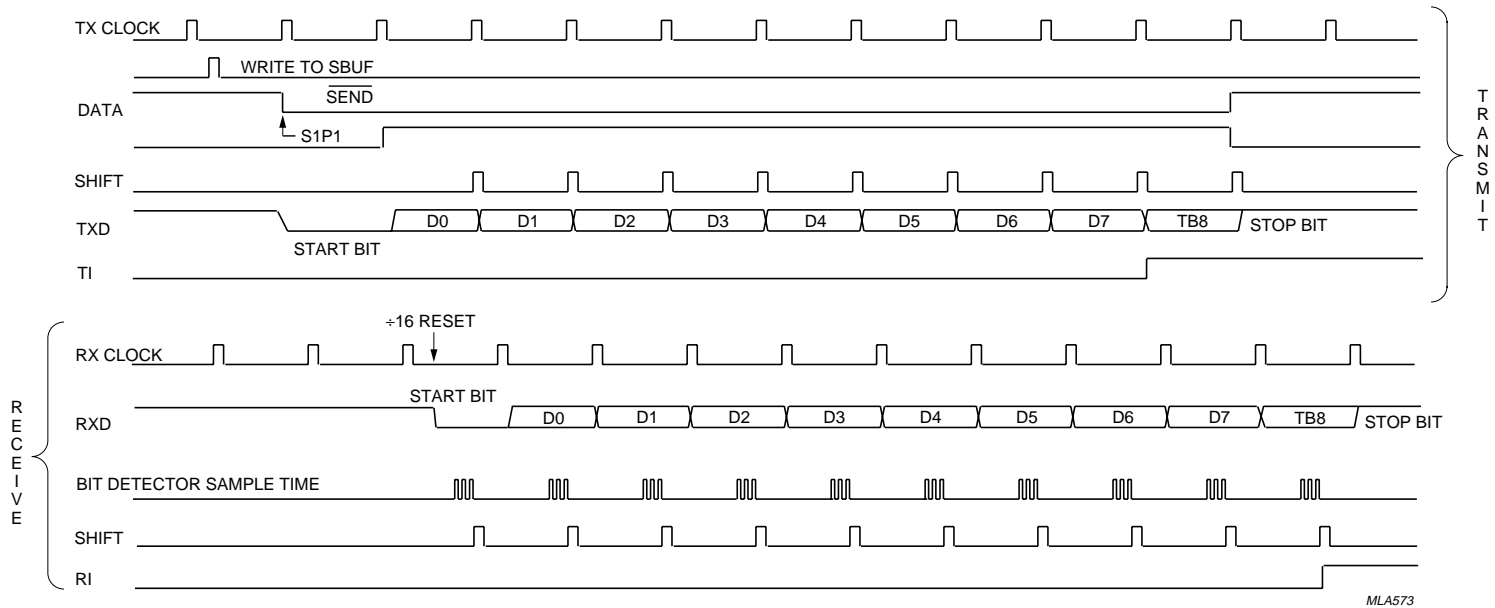


Fig.24 Serial port Mode 3 timing.

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18 INTERRUPT SYSTEM

External events and the real-time-driven on-chip peripherals require service by the CPU asynchronously to the execution of any particular section of code. To tie the asynchronous activities of these functions to normal program execution a multiple-source, two-priority-level, nested interrupt system is provided. The SZF2002 acknowledges interrupt requests from fifteen sources as follows:

- $\overline{\text{INT0}}$ to $\overline{\text{INT8}}$
- Timer 0, Timer 1 and Timer 2
- I²C-bus serial I/O
- UART
- ADC.

Each interrupt vectors to a separate location in program memory for its service routine. Each source can be individually enabled or disabled by corresponding bits in the Interrupt Enable Registers (IEN0 and IEN1). The priority level is selected via the Interrupt Priority Registers (IP0 and IP1). All enabled sources can be globally disabled or enabled. Figure 25 shows the interrupt system.

18.1 External interrupts $\overline{\text{INT2}}$ to $\overline{\text{INT8}}$

Port 1 lines serve an alternative purpose as seven additional interrupts $\overline{\text{INT2}}$ to $\overline{\text{INT8}}$. When enabled, each of these lines (as well as $\overline{\text{INT0}}$ and $\overline{\text{INT1}}$) may wake-up the device from the Power-down mode. Using the Interrupt Polarity Register (IX1), each pin may be initialized to be either active HIGH or active LOW. IRQ1 is the Interrupt Request Flag Register. If the interrupt is enabled, each flag will be set on an interrupt request but must be cleared by software, i.e. via the interrupt software or when the interrupt is disabled.

A low priority interrupt can be interrupted by a high priority interrupt but not by another low priority interrupt. A high priority interrupt routine can not be interrupted by any other interrupt. If two interrupt requests of different priority levels are received simultaneously, the request having the highest priority level will be serviced. If interrupt requests of the same priority level are received simultaneously an internal polling sequence determines which request is serviced. Thus within each priority level there is a second priority structure determined by the polling sequence (see Fig.25).

Port 1 interrupts are level sensitive. A Port 1 interrupt will be recognized when a level (longer than 2 machine cycles, HIGH or LOW, depending on the Interrupt Polarity Register) on P1.n is made. The interrupt request is not serviced until the next machine cycle. Figure 26 shows the external interrupt system.

18.2 Interrupt priority

Each interrupt source can be set to either a high priority or to a low priority. If interrupts of the same priority are requested simultaneously, the processor will branch to the interrupt polled first, according to Table 36.

A low priority interrupt routine can only be interrupted by a high priority interrupt. A high priority interrupt routine can not be interrupted.

Table 36 shows the interrupt vectors in order of priority. The vector indicates the ROM location where the appropriate interrupt service routine starts.

Table 36 Interrupt vectors

SYMBOL	VECTOR ADDRESS (HEX)	SOURCE
X0 (highest)	0003	external interrupt 0
S1	002B	I ² C-bus port
X5	0053	external interrupt 5
T0	000B	Timer 0
T2	0033	Timer 2
X6	005B	external interrupt 6
X1	0013	external interrupt 1
X2	003B	external interrupt 2
X7	0063	external interrupt 7
T1	001B	Timer 1
X3	0043	external interrupt 3
X8	006B	external interrupt 8
SO	0023	UART
X4	004B	external interrupt 4
ADC (lowest)	0073	ADC

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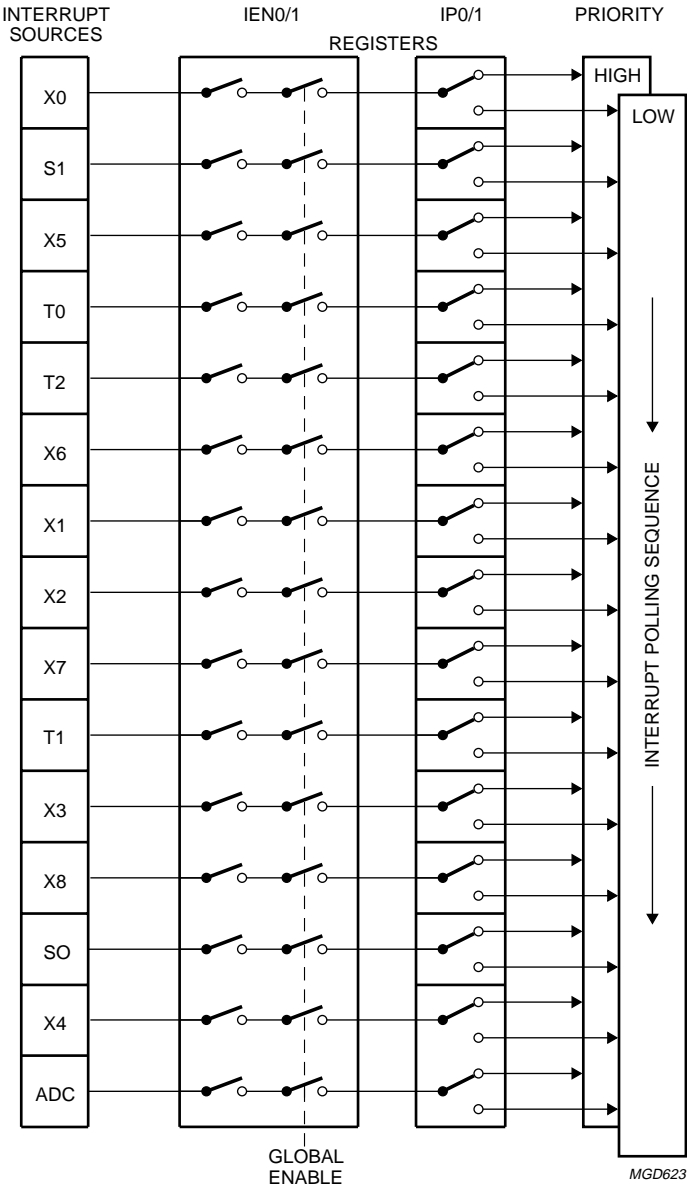
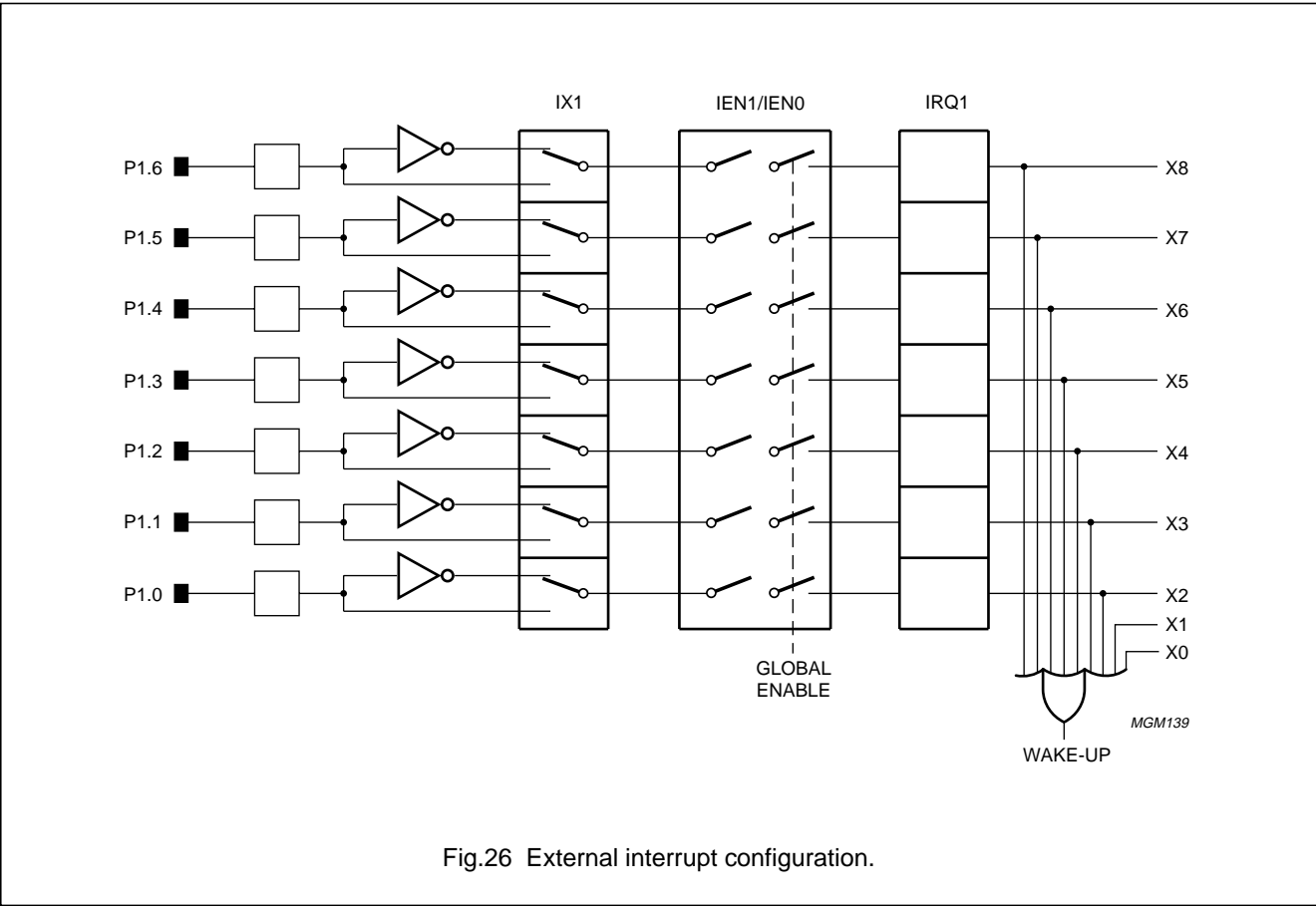


Fig.25 Interrupt system.

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18.3 Interrupt related registers

The registers IEN0, IEN1, IP0, IP1, IX1 and IRQ1 are used in conjunction with the interrupt system.

Table 37 Special Function Registers related to the interrupt system

ADDRESS	REGISTER	DESCRIPTION
A8H	IEN0	Interrupt Enable Register 0
E8H	IEN1	Interrupt Enable Register 1 ($\overline{\text{INT2}}$ to $\overline{\text{INT8}}$)
B8H	IP0	Interrupt Priority Register 0
F8H	IP1	Interrupt Priority Register 1 ($\overline{\text{INT2}}$ to $\overline{\text{INT8}}$ and ADC)
E9H	IX1	Interrupt Polarity Register
C0H	IRQ1	Interrupt Request Flag Register

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18.3.1 INTERRUPT ENABLE REGISTER 0 (IEN0)

Bit values: 0 = interrupt disabled; 1 = interrupt enabled.

Table 38 Interrupt Enable Register 0 (SFR address A8H)

7	6	5	4	3	2	1	0
EA	ET2	ES1	ES0	ET1	EX1	ET0	EX0

Table 39 Description of IEN0 bits

BIT	SYMBOL	DESCRIPTION
7	EA	General enable/disable control. If EA = 0, no interrupt is enabled; if EA = 1, any individually enabled interrupt will be accepted.
6	ET2	enable T2 interrupt
5	ES1	enable I ² C-bus interrupt
4	ES0	enable UART SIO interrupt
3	ET1	enable Timer 1 interrupt (T1)
2	EX1	enable external interrupt 1
1	ET0	enable Timer 0 interrupt (T0)
0	EX0	enable external interrupt 0

18.3.2 INTERRUPT ENABLE REGISTER 1 (IEN1)

Bit values: 0 = interrupt disabled; 1 = interrupt enabled.

Table 40 Interrupt Enable Register 1 (SFR address E8H)

7	6	5	4	3	2	1	0
EAD	EX8	EX7	EX6	EX5	EX4	EX3	EX2

Table 41 Description of IEN1 bits

BIT	SYMBOL	DESCRIPTION
7	EAD	enable ADC interrupt (external interrupt 9)
6	EX8	enable external interrupt 8
5	EX7	enable external interrupt 7
4	EX6	enable external interrupt 6
3	EX5	enable external interrupt 5
2	EX4	enable external interrupt 4
1	EX3	enable external interrupt 3
0	EX2	enable external interrupt 2

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18.3.3 INTERRUPT PRIORITY REGISTER 0 (IP0)

Bit values: 0 = low priority; 1 = high priority.

Table 42 Interrupt Priority Register 0 (SFR address B8H)

7	6	5	4	3	2	1	0
–	PT2	PS1	PS0	PT1	PX1	PT0	PX0

Table 43 Description of IP0 bits

BIT	SYMBOL	DESCRIPTION
7	–	reserved
6	PT2	Timer 2 interrupt priority level
5	PS1	I ² C-bus interrupt priority level
4	PS0	UART SIO interrupt priority level
3	PT1	Timer 1 interrupt priority level
2	PX1	external interrupt 1 priority level
1	PT0	Timer 0 interrupt priority level
0	PX0	external interrupt 0 priority level

18.3.4 INTERRUPT PRIORITY REGISTER 1 (IP1)

Bit values: 0 = low priority; 1 = high priority.

Table 44 Interrupt Priority Register 1 (SFR address F8H)

7	6	5	4	3	2	1	0
PADC	PX8	PX7	PX6	PX5	PX4	PX3	PX2

Table 45 Description of IP1 bits

BIT	SYMBOL	DESCRIPTION
7	PADC	ADC interrupt priority level
6	PX8	external interrupt 8 priority level
5	PX7	external interrupt 7 priority level
4	PX6	external interrupt 6 priority level
3	PX5	external interrupt 5 priority level
2	PX4	external interrupt 4 priority level
1	PX3	external interrupt 3 priority level
0	PX2	external interrupt 2 priority level

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18.3.5 INTERRUPT POLARITY REGISTER (IX1)

Writing either a logic 1 or logic 0 to any Interrupt Polarity Register bit sets the polarity level of the corresponding external interrupt to an active HIGH or active LOW respectively.

Table 46 Interrupt Polarity Register (SFR address E9H)

7	6	5	4	3	2	1	0
–	IL8	IL7	IL6	IL5	IL4	IL3	IL2

Table 47 Description of IX1 bits

BIT	SYMBOL	DESCRIPTION
7	–	reserved
6	IL8	external interrupt 8 polarity level
5	IL7	external interrupt 7 polarity level
4	IL6	external interrupt 6 polarity level
3	IL5	external interrupt 5 polarity level
2	IL4	external interrupt 4 polarity level
1	IL3	external interrupt 3 polarity level
0	IL2	external interrupt 2 polarity level

18.3.6 INTERRUPT REQUEST FLAG REGISTER (IRQ1)

Table 48 Interrupt Request Flag Register (SFR address C0H)

7	6	5	4	3	2	1	0
–	IQ8	IQ7	IQ6	IQ5	IQ4	IQ3	IQ2

Table 49 Description of IRQ1 bits

BIT	SYMBOL	DESCRIPTION
7	–	reserved
6	IQ8	external interrupt 8 request flag
5	IQ7	external interrupt 7 request flag
4	IQ6	external interrupt 6 request flag
3	IQ5	external interrupt 5 request flag
2	IQ4	external interrupt 4 request flag
1	IQ3	external interrupt 3 request flag
0	IQ2	external interrupt 2 request flag

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19 CLOCK CIRCUITRY

The SZF2002 is clocked with an external digital clock.

The input must be driven with a digital square wave.

Note that the duty cycle influences the timing to the external components, since both the positive and negative clock edges are used.

20 RESET

To initialize the SZF2002 a reset is performed by either of two methods:

- Applying an external signal to the RST pin
- Watchdog Timer overflow.

20.1 External reset using the RST pin

The reset input for the SZF2002 is RST. A reset is accomplished by holding the RST pin HIGH for at least two machine cycles (12 clock periods) while the clock is running. The CPU responds by executing an internal reset. Port pins adopt their reset state immediately after the RST goes HIGH. During reset, \overline{WE} and \overline{OE} , and \overline{CE} are held HIGH.

The external reset is asynchronous to the internal clock. The RST pin is sampled during state 5, phase 2 of every machine cycle. After a HIGH is detected at the RST pin, an internal reset is repeated until RST goes LOW. The reset circuitry is also affected by the Watchdog Timer as described in Section 12.5. The internal RAM is not affected by reset. When V_{DD} is turned on, the RAM contents are indeterminate.

20.2 Power-on-reset

The device contains on-chip circuitry which switches the port pins to HIGH as soon as RST goes HIGH. The user must ensure that the RST pin is held HIGH until the external clock has stabilised. When RST goes LOW a further 3 cycles elapse before execution starts.

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21 SPECIAL FUNCTION REGISTERS OVERVIEW

ADDRESS (HEX)	NAME	RESET VALUE (B)	FUNCTION
FF	T3	0000 0000	Watchdog Timer
FE	PWMP ⁽¹⁾	0000 0000	Prescaler Frequency Control Register
FC	PWM ⁽¹⁾	0000 0000	Pulse Width Register
F8	IP1 ⁽¹⁾⁽²⁾	0000 0000	Interrupt Priority Register 1 ($\overline{\text{INT2}}$ to $\overline{\text{INT8}}$ and ADC)
F7	WDTKEY ⁽¹⁾	0000 0000	Watchdog Timer enable
F0	B ⁽²⁾	0000 0000	B Register
E9	IX1 ⁽¹⁾	X000 0000	Interrupt Polarity Register 1
E8	IEN1 ⁽¹⁾⁽²⁾	0000 0000	Interrupt Enable Register 1
E0	ACC ⁽²⁾	0000 0000	Accumulator
DB	S1ADR ⁽¹⁾	0000 0000	I ² C-bus Slave Address Register
DA	S1DAT ⁽¹⁾	0000 0000	I ² C-bus Data Shift Register
D9	S1STA ⁽¹⁾	1111 1000	I ² C-bus Serial Status Register
D8	S1CON ⁽¹⁾⁽²⁾	0000 0000	I ² C-bus Serial Control Register
D0	PSW ⁽²⁾	0000 0000	Program Status Word
CD	TH2 ⁽¹⁾	0000 0000	Timer 2 High byte
CC	TL2 ⁽¹⁾	0000 0000	Timer 2 Low byte
CB	RCAP2H ⁽¹⁾	0000 0000	Timer 2 Reload/Capture Register High byte
CA	RCAP2L ⁽¹⁾	0000 0000	Timer 2 Reload/Capture Register Low byte
C9	T2MOD ⁽¹⁾	XX00 X000	Timer/Counter 2 mode control
C8	T2CON ⁽¹⁾⁽²⁾	0000 0000	Timer/Counter 2 Control Register
C5	ADCH ⁽¹⁾	1111 1111	ADC Result Register
C4	ADCON ⁽¹⁾	X000 0000	ADC Control Register
C1	P4 ⁽¹⁾	1111 1111	Digital I/O Port Register 4
C0	IRQ1 ⁽¹⁾⁽²⁾	X000 0000	Interrupt Request Flag Register
B8	IP0 ⁽²⁾	X000 0000	Interrupt Priority Register 0
B0	P3 ⁽²⁾	1111 1111	Digital I/O Port Register 3
A8	IEN0 ⁽²⁾	0000 0000	Interrupt Enable Register 0
A0	P2 ⁽²⁾	1111 1111	Digital I/O Port Register 2

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ADDRESS (HEX)	NAME	RESET VALUE (B)	FUNCTION
99	S0BUF	XXXX XXXX	Serial Data Buffer Register 0
98	S0CON ⁽²⁾	0000 0000	Serial Port Control Register 0
91	ROMBANK ⁽¹⁾	XXXX X000	ROM bank Selection Register
90	P1 ⁽²⁾	1111 1111	Digital I/O Port Register 1
8D	TH1	0000 0000	Timer 1 High byte
8C	TH0	0000 0000	Timer 0 High byte
8B	TL1	0000 0000	Timer 1 Low byte
8A	TL0	0000 0000	Timer 0 Low byte
89	TMOD	0000 0000	Timer 0 and 1 Mode Control Register
88	TCON ⁽²⁾	0000 0000	Timer 0 and 1 Control/External Interrupt Control Register
87	PCON	0000 0000	Power Control Register
83	DPH	0000 0000	Data Pointer High byte
82	DPL	0000 0000	Data Pointer Low byte
81	SP	0000 0111	Stack Pointer
80	P0 ⁽²⁾	1111 1111	Digital I/O Port Register 0

Notes

1. SZF2002 specific SFRs.
2. Bit addressed register.

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22 DEBUGGING SUPPORT

For software development the SZF2002 is made compatible with the Nohau 80C51 In-Circuit Emulator (ICE).

22.1 Recommended equipment

1. Nohau EMUL51-PC/EA768-BSW-42 42 MHz, 768-kbyte emulator memory board.
2. Nohau EMUL51-PC/ATR64-33, 33 MHz, 64-kbyte advanced trace memory board.
3. Nohau EMUL51-PC/POD-C32HF-42, external memory mode pod for a.o. 80C51/80C32.

22.2 Connecting the pod

The Nohau In-Circuit Emulator requires the following 80C51 pins: P0.0 to P0.7, P2.0 to P2.7, ALE, $\overline{\text{PSEN}}$, $\overline{\text{RD}}$, $\overline{\text{WR}}$, $\overline{\text{EA}}$ and RST.

When setting the SZF2002 in Debug mode (force DEBUG HIGH), these signals become available on the pins as described in Section 7.2

The connection between the SZF2002 and the emulator is shown in Fig.27.

For emulation the Target board must be configured with the SZF2002 mounted, but without external Flash and RAM, or disabled by disconnecting the $\overline{\text{OE}}$.

On the Target board a 40-pin connector is required that has all the necessary 80C51 signals (Port 0, Port 2, $\overline{\text{PSEN}}$, ALE, $\overline{\text{EA}}$, RST, V_{DD} and V_{SS}). The 16 port pins are optional. The three banking bits are not standard 80C51 signals and are not available at the DIL40 80C51-connector of the pod. These three bits must be connected via three separate wires to the signals BS0 (LSB), BS1 and BS2 (MSB) on the pod.

The emulator pod has a DIL40 socket for the 80C51 processor (on the upper side). By connecting the 40-pin connector to this socket the emulator will approach the SZF2002 as if it were a 80C51. The connector on the lower side of the pod is not used. The emulator acts as a memory emulator.

22.3 Powering the pod

Because the SZF2002 is a 3 V circuit, the ICE pod must be powered by the target (supply from PC is not possible, see documentation for EMUL51-PC/POD-C32HF-42). Therefore, V_{DD} and V_{SS} for the SZF2002 are also required. The clock signal is **not** required on the pod.

The digital power V_{DD} has to be connected to the pod. The ground of the pod must be connected to the ground of the target board via the black gnd-wire soldered to the pod

Because the target supplies the pod the following power-up/power-down sequence is required:

1. Switch on target.
2. Switch on PC.
3. Switch off target.

When using 3 V power from the target, note that the pod will drive the inputs up to 3.5 V. Some current will also flow through the V_{DD} connection to the target. If the emulator is used together with an I²C-bus interface to a PC or together with an RS232-connection, use 3.3 V power for the target. This will reduce noise and disturbance on all input and output signals. In practice, it is seen that this will result in a more robust communication between the SZF2002 and Nohau.

Both I²C-bus pins (SDA and SCL) need an external pull-up resistor.

22.4 Bank switching support

If bank switching is required, the in-circuit emulator also needs the TRUE_A15 and the three banking bits A15 to A17.

16 port pins (selection of Ports 3 and 4) can also be connected to the emulator pod, however this is not necessary. When connected, the state of these ports can be traced.

To set up the banking configuration the BM jumpers on the emulator board have to be set. The following set-up is recommended:

1. Jumper BM3 is out.
2. Jumper BM2 is out.
3. Jumper BM1 is don't care.
4. Jumper BM0 is in.

22.5 Software recommendations

The Keil/Franklin assembler and banked linker is well suited for use with the Nohau ICE (especially for banking configurations).

The Nohau ICE communicates with the SZF2002 using MOVX instructions. Therefore, all MOVX instructions must be forced to access off-chip memory instead of internal AUX RAM by setting the ARD bit of the SFR PCON.

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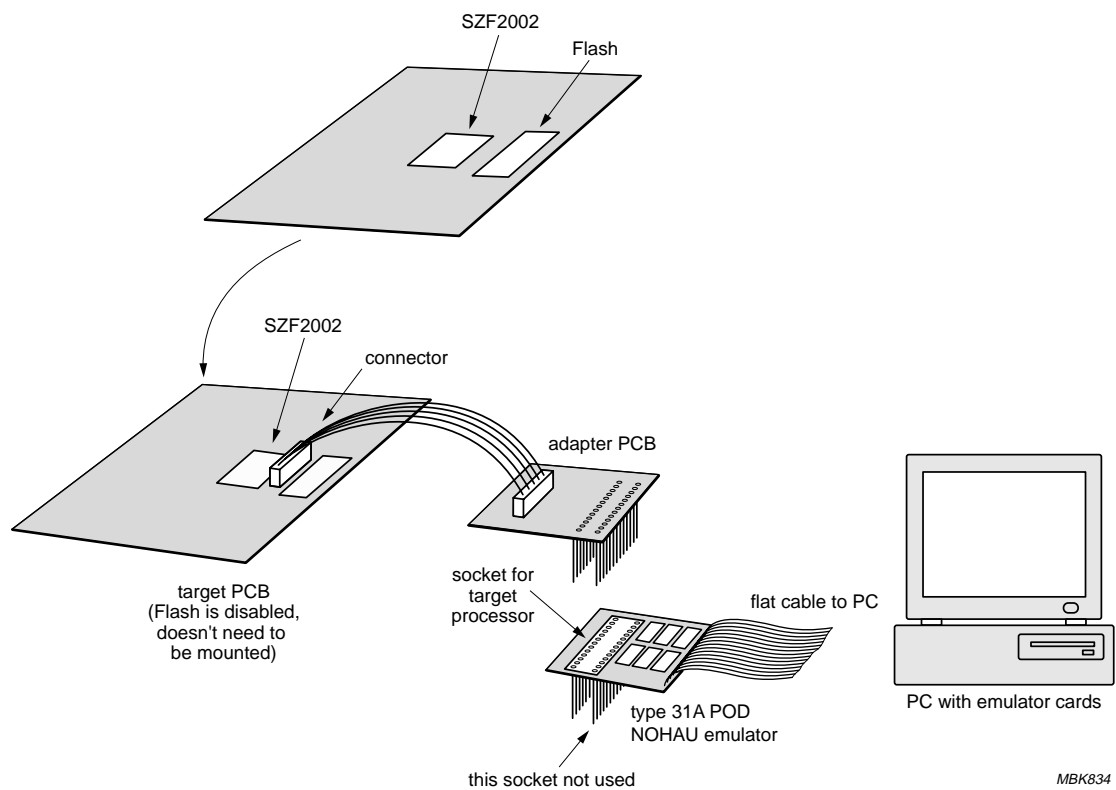


Fig.27 In-circuit emulation.

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23 INSTRUCTION SET

The SZF2002 uses a powerful instruction set which optimizes byte efficiency and execution speed. Assigned opcodes add new high-power operation and permit new addressing modes. The instruction set consists of 49 single-byte, 46 two-byte and 16 three-byte instructions. When using a 12 MHz clock, 64 instructions execute in 0.5 μ s and 45 instructions execute in 1 μ s. Multiply and divide instructions execute in 2 μ s.

For the description of the **Data Addressing modes** and **Hexadecimal opcode cross-reference** see Table 54.

Table 50 Instruction set description: Arithmetic operations

MNEMONIC	DESCRIPTION	BYTES	CYCLES	OPCODE (HEX)
Arithmetic operations				
ADD A,Rr	add register to A	1	1	2*
ADD A,direct	add direct byte to A	2	1	25
ADD A,@Ri	add indirect RAM to A	1	1	26 and 27
ADD A,#data	add immediate data to A	2	1	24
ADDC A,Rr	add register to A with carry flag	1	1	3*
ADDC A,direct	add direct byte to A with carry flag	2	1	35
ADDC A,@Ri	add indirect RAM to A with carry flag	1	1	36 and 37
ADDC A,#data	add immediate data to A with carry flag	2	1	34
SUBB A,Rr	subtract register from A with borrow	1	1	9*
SUBB A,direct	subtract direct byte from A with borrow	2	1	95
SUBB A,@Ri	subtract indirect RAM from A with borrow	1	1	96 and 97
SUBB A,#data	subtract immediate data from A with borrow	2	1	94
INC A	increment A	1	1	04
INC Rr	increment register	1	1	0*
INC direct	increment direct byte	2	1	05
INC @Ri	increment indirect RAM	1	1	06 and 07
DEC A	decrement A	1	1	14
DEC Rr	decrement register	1	1	1*
DEC direct	decrement direct byte	2	1	15
DEC @Ri	decrement indirect RAM	1	1	16 and 17
INC DPTR	increment data pointer	1	2	A3
MUL AB	multiply A and B	1	4	A4
DIV AB	divide A by B	1	4	84
DA A	decimal adjust A	1	1	D4

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Table 51 Instruction set description: Logic operations

MNEMONIC		DESCRIPTION	BYTES	CYCLES	OPCODE (HEX)
Logic operations					
ANL	A,Rr	AND register to A	1	1	5*
ANL	A,direct	AND direct byte to A	2	1	55
ANL	A,@Ri	AND indirect RAM to A	1	1	56 and 57
ANL	A,#data	AND immediate data to A	2	1	54
ANL	direct,A	AND A to direct byte	2	1	52
ANL	direct,#data	AND immediate data to direct byte	3	2	53
ORL	A,Rr	OR register to A	1	1	4*
ORL	A,direct	OR direct byte to A	2	1	45
ORL	A,@Ri	OR indirect RAM to A	1	1	46 and 47
ORL	A,#data	OR immediate data to A	2	1	44
ORL	direct,A	OR A to direct byte	2	1	42
ORL	direct,#data	OR immediate data to direct byte	3	2	43
XRL	A,Rr	exclusive-OR register to A	1	1	6*
XRL	A,direct	exclusive-OR direct byte to A	2	1	65
XRL	A,@Ri	exclusive-OR indirect RAM to A	1	1	66 and 67
XRL	A,#data	exclusive-OR immediate data to A	2	1	64
XRL	direct,A	exclusive-OR A to direct byte	2	1	62
XRL	direct,#data	exclusive-OR immediate data to direct byte	3	2	63
CLR	A	clear A	1	1	E4
CPL	A	complement A	1	1	F4
RL	A	rotate A left	1	1	23
RLC	A	rotate A left through the carry flag	1	1	33
RR	A	rotate A right	1	1	03
RRC	A	rotate A right through the carry flag	1	1	13
SWAP	A	swap nibbles within A	1	1	C4

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Table 52 Instruction set description: Data transfer

MNEMONIC	DESCRIPTION	BYTES	CYCLES	OPCODE (HEX)
Data transfer				
MOV A,Rr	move register to A	1	1	E*
MOV A,direct (note 1)	move direct byte to A	2	1	E5
MOV A,@Ri	move indirect RAM to A	1	1	E6 and E7
MOV A,#data	move immediate data to A	2	1	74
MOV Rr,A	move A to register	1	1	F*
MOV Rr,direct	move direct byte to register	2	2	A*
MOV Rr,#data	move immediate data to register	2	1	7*
MOV direct,A	move A to direct byte	2	1	F5
MOV direct,Rr	move register to direct byte	2	2	8*
MOV direct,direct	move direct byte to direct	3	2	85
MOV direct,@Ri	move indirect RAM to direct byte	2	2	86 and 87
MOV direct,#data	move immediate data to direct byte	3	2	75
MOV @Ri,A	move A to indirect RAM	1	1	F6 and F7
MOV @Ri,direct	move direct byte to indirect RAM	2	2	A6 and A7
MOV @Ri,#data	move immediate data to indirect RAM	2	1	76 and 77
MOV DPTR,#data 16	load data pointer with a 16-bit constant	3	2	90
MOVC A,@A+DPTR	move code byte relative to DPTR to A	1	2	93
MOVC A,@A+PC	move code byte relative to PC to A	1	2	83
MOVX A,@Ri	move external RAM (8-bit address) to A	1	2	E2 and E3
MOVX A,@DPTR	move external RAM (16-bit address) to A	1	2	E0
MOVX @Ri,A	move A to external RAM (8-bit address)	1	2	F2 and F3
MOVX @DPTR,A	move A to external RAM (16-bit address)	1	2	F0
PUSH direct	push direct byte onto stack	2	2	C0
POP direct	pop direct byte from stack	2	2	D0
XCH A,Rr	exchange register with A	1	1	C*
XCH A,direct	exchange direct byte with A	2	1	C5
XCH A,@Ri	exchange indirect RAM with A	1	1	C6 and C7
XCHD A,@Ri	exchange LOW-order digit indirect RAM with A	1	1	D6 and D7

Note

1. MOV A,ACC is not permitted.

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Table 53 Instruction set description: Boolean variable manipulation and Program and machine control

MNEMONIC		DESCRIPTION	BYTES	CYCLES	OPCODE (HEX)
Boolean variable manipulation					
CLR	C	clear carry flag	1	1	C3
CLR	bit	clear direct bit	2	1	C2
SETB	C	set carry flag	1	1	D3
SETB	bit	set direct bit	2	1	D2
CPL	C	complement carry flag	1	1	B3
CPL	bit	complement direct bit	2	1	B2
ANL	C,bit	AND direct bit to carry flag	2	2	82
ANL	C,/bit	AND complement of direct bit to carry flag	2	2	B0
ORL	C,bit	OR direct bit to carry flag	2	2	72
ORL	C,/bit	OR complement of direct bit to carry flag	2	2	A0
MOV	C,bit	move direct bit to carry flag	2	1	A2
MOV	bit,C	move carry flag to direct bit	2	2	92
Program and machine control					
ACALL	addr11	absolute subroutine call	2	2	•1
LCALL	addr16	long subroutine call	3	2	12
RET		return from subroutine	1	2	22
RETI		return from interrupt	1	2	32
AJMP	addr11	absolute jump	2	2	♦1
LJMP	addr16	long jump	3	2	02
SJMP	rel	short jump (relative address)	2	2	80
JMP	@A+DPTR	jump indirect relative to the DPTR	1	2	73
JZ	rel	jump if A is zero	2	2	60
JNZ	rel	jump if A is not zero	2	2	70
JC	rel	jump if carry flag is set	2	2	40
JNC	rel	jump if carry flag is not set	2	2	50
JB	bit,rel	jump if direct bit is set	3	2	20
JNB	bit,rel	jump if direct bit is not set	3	2	30
JBC	bit,rel	jump if direct bit is set and clear bit	3	2	10
CJNE	A,direct,rel	compare direct to A and jump if not equal	3	2	B5
CJNE	A,#data,rel	compare immediate to A and jump if not equal	3	2	B4
CJNE	Rr,#data,rel	compare immediate to register and jump if not equal	3	2	B*
CJNE	@Ri,#data,rel	compare immediate to indirect and jump if not equal	3	2	B6 and B7
DJNZ	Rr,rel	decrement register and jump if not zero	2	2	D*
DJNZ	direct,rel	decrement direct and jump if not zero	3	2	D5
NOP		no operation	1	1	00

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Table 54 Description of the mnemonics in the Instruction set

MNEMONIC	DESCRIPTION
Data addressing modes	
Rr	Working registers R0 to R7.
direct	128 internal RAM locations and any special function register (SFR).
@Ri	Indirect internal RAM location addressed by register R0 or R1 of the actual register bank.
#data	8-bit constant included in instruction.
#data 16	16-bit constant included as bytes 2 and 3 of instruction.
bit	Direct addressed bit in internal RAM or SFR.
addr16	16-bit destination address. Used by LCALL and LJMP. The branch will be anywhere within the 64 kbytes program memory address space.
addr11	11-bit destination address. Used by ACALL and AJMP. The branch will be within the same 2 kbytes page of program memory as the first byte of the following instruction.
rel	Signed (two's complement) 8-bit offset byte. Used by SJMP and all conditional jumps. Range is –128 to + 127 bytes relative to first byte of the following instruction.
Hexadecimal opcode cross-reference	
*	8, 9, A, B, C, D, E and F.
•	1, 3, 5, 7, 9, B, D and F.
♦	0, 2, 4, 6, 8, A, C and E.

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Table 55 Instruction map

First hexadecimal character of opcode				← Second hexadecimal character of opcode →															
↓	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F			
0	NOP	AJMP addr11	LJMP addr16	RR A	INC A	INC direct	INC @Ri		INC Rr								0	1	2
1	JBC bit,rel	ACALL addr11	LCALL addr16	RRC A	DEC A	DEC direct	DEC @Ri		DEC Rr								0	1	2
2	JB bit,rel	AJMP addr11	RET	RL A	ADD A,#data	ADD A,direct	ADD A,@Ri		ADD A,Rr								0	1	2
3	JNB bit,rel	ACALL addr11	RETI	RLC A	ADDC A,#data	ADDC A,direct	ADDC A,@Ri		ADDC A,Rr								0	1	2
4	JC rel	AJMP addr11	ORL direct,A	ORL direct,#data	ORL A,#data	ORL A,direct	ORL A,@Ri		ORL A,Rr								0	1	2
5	JNC rel	ACALL addr11	ANL direct,A	ANL direct,#data	ANL A,#data	ANL A,direct	ANL A,@Ri		ANL A,Rr								0	1	2
6	JZ rel	AJMP addr11	XRL direct,A	XRL direct,#data	XRL A,#data	XRL A,direct	XRL A,@Ri		XRL A,Rr								0	1	2
7	JNZ rel	ACALL addr11	ORL C,bit	JMP @A+DPTR	MOV A,#data	MOV direct,#data	MOV @Ri,#data		MOV Rr,#data								0	1	2
8	SJMP rel	AJMP addr11	ANL C,bit	MOVC A,@A+PC	DIV AB	MOV direct,direct	MOV direct,@Ri		MOV direct,Rr								0	1	2
9	MOV DTPR,#data16	ACALL addr11	MOV bit,C	MOVC A,@A+DPTR	SUBB A,#data	SUBB A,direct	SUBB A,@Ri		SUB A,Rr								0	1	2
A	ORL C,/bit	AJMP addr11	MOV bit,C	INC DPTR	MUL AB		MOV @Ri,direct		MOV Rr,direct								0	1	2
B	ANL C,/bit	ACALL addr11	CPL bit	CPL C	CJNE A,#data,rel	CJNE A,direct,rel	CJNE @Ri,#data,rel		CJNE Rr,#data,rel								0	1	2
C	PUSH direct	AJMP addr11	CLR bit	CLR C	SWAP A	XCH A,direct	XCH A,@Ri		XCH A,Rr								0	1	2
D	POP direct	ACALL addr11	SETB bit	SETB C	DA A	DJNZ direct,rel	XCHD A,@Ri		DJNZ Rr,rel								0	1	2
E	MOVX A,@DTPR	AJMP addr11	MOVX A,@Ri		CLR A	MOV A,direct ⁽¹⁾	MOV A,@Ri		MOV A,Rr								0	1	2
F	MOVX @DTPR,A	ACALL addr11	MOVX @Ri,A		CPL A	MOV direct,A	MOV @Ri,A		MOV Rr,A								0	1	2

Note

- MOV A, ACC is not a valid instruction.

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24 LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
V_{DD}	supply voltage	−0.5	+5	V
V_I	input voltage on any pin with respect to ground (V_{SS})	−0.5	$V_{DD} + 0.5$	V
I_I and I_O	DC current on any input or output	−	tbef	mA
P_{tot}	total power dissipation	−	500	mW
T_{stg}	storage temperature	−65	+150	°C
T_{amb}	operating ambient temperature	−40	+85	°C
T_j	operating junction temperature	−40	+125	°C

25 DC CHARACTERISTICS

$V_{DD} = 2.7$ to 3.3 V; $V_{SS} = 0$ V; $T_{amb} = -40$ to $+85$ °C; see note 1; all voltages are with respect to V_{SS} ; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Supply						
V_{DD}	operating supply voltage		2.7	−	3.3	V
I_{DD}	operating supply current	$V_{DD} = 3.0$ V; $f_{CLK} = 8$ MHz; note 2	−	−	9	mA
		$V_{DD} = 3.0$ V; $f_{CLK} = 3.58$ MHz; note 2	−	−	2.5	mA
$I_{DD(idle)}$	Idle mode supply current	$V_{DD} = 3.0$ V; $f_{CLK} = 8$ MHz; note 3	−	−	5.0	mA
		$V_{DD} = 3.0$ V; $f_{CLK} = 3.58$ MHz; note 3	−	−	1.5	mA
$I_{DD(pd)}$	Power-down mode current	$V_{DD} = 3.0$ V; $T_{amb} = 25$ °C; note 4	−	−	10	μA
Inputs (note 5)						
V_{IL}	LOW-level input voltage		V_{SS}	−	$0.2V_{DD}$	V
V_{IH}	HIGH-level input voltage		$0.8V_{DD}$	−	V_{DD}	V
I_{LI}	input leakage current	$V_{SS} < V_i < V_{DD}$; $V_{DD} = 3.0$ V; $T_{amb} = 25$ °C	−1	−	+1	μA
I_{IL}	input pull-up current	Input = HIGH	−	−	tbef	μA
Outputs						
V_{OL}	LOW-level output voltage		−	−	0.4	V
V_{OH}	HIGH-level output voltage		$V_{DD} - 0.4$	−	−	V
I_{OL}	LOW-level output current		4.0	−	−	mA
I_{OH}	HIGH-level output current		−4.0	−	−	mA
R_{RST}	RST pull-down resistor		120	160	250	kΩ
Analog inputs						
V_{DDA}	analog supply voltage		$V_{DD} - 0.5$	−	$V_{DD} + 0.5$	V
I_{DDA}	supply current operating	$V_{DDA} = 3.0$ V; $f_{CLK} = 8$ MHz; note 2	−	−	0.5	mA

Notes to the DC characteristics

1. Loading ports and busses may cause spurious noise pulses to be superimposed on the output voltage.

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- The operating supply current is measured with all output pins disconnected; CLK driven with $t_r = t_f = 10$ ns; $V_{IL} = V_{SS}$; $V_{IH} = V_{DD}$; $\overline{EA} = RST = \text{Port 0} = V_{DD}$.
- The Idle mode supply current is measured with all output pins disconnected; CLK driven with $t_r = t_f = 10$ ns; $V_{IL} = V_{SS}$; $V_{IH} = V_{DD}$; $\overline{EA} = \text{Port 0} = V_{DD}$.
- The power-down current is measured with all output pins disconnected; CLK connected to V_{SS} ; $\overline{EA} = \text{Port 0} = V_{DD}$; $RST = V_{SS}$.
- The input threshold voltage of P1.6/SCL and P1.7/SDA meet the I²C-bus specification. Therefore, an input voltage below $0.3V_{DD}$ will be recognized as a logic 0 and an input voltage above $0.7V_{DD}$ will be recognized as a logic 1.

26 ADC CHARACTERISTICS

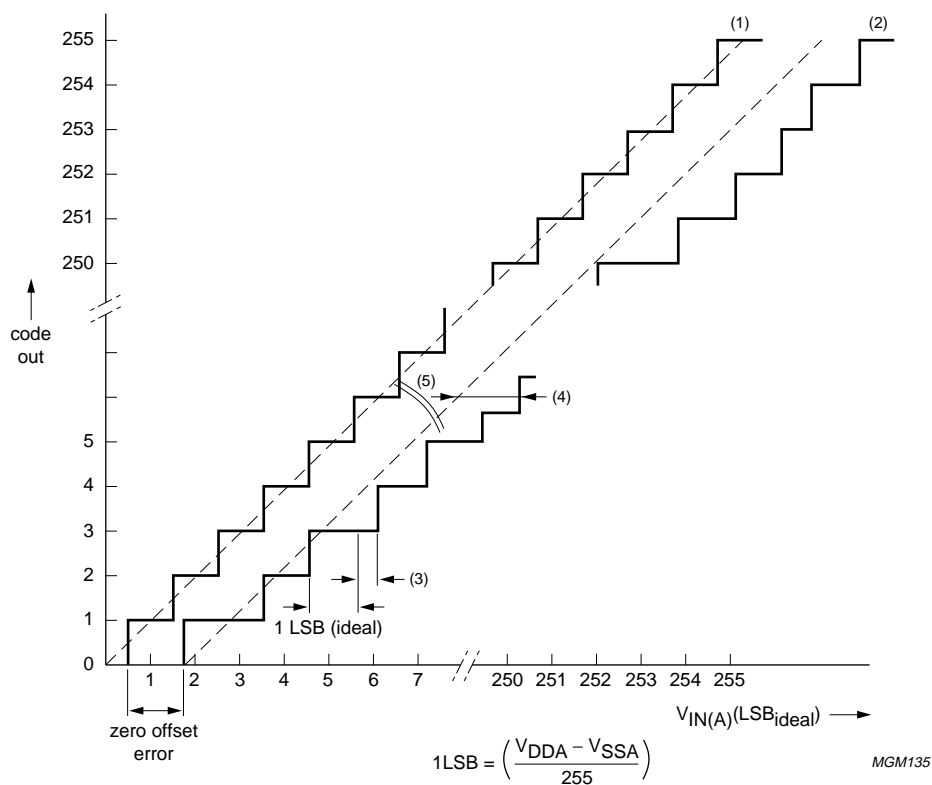
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{IN(ADC)}$	ADC input voltage	note 1	V_{SSA}	—	$0.5V_{DDA}$	V
V_{DDA}	analog supply voltage		$V_{DD} - 0.5$	—	$V_{DD} + 0.5$	V
I_{DDA}	supply current operating	$V_{DDA} = 3.0$ V; $f_{clk} = 8$ MHz	—	—	0.5	mA
C_{AIN}	analog on-chip input capacitance		—	—	2	pF
R_{AIN}	analog on-chip input impedance		10	—	—	M Ω
G_e	Gain error; note 2		−1	—	+1	%
OS_e	zero-offset error; note 3		−1	—	+1	LSB
DNL	differential non-linearity; note 4		−0.5	—	+0.5	LSB
INL	Integral non-linearity; note 5		−1	—	+1	LSB
M_{ctc}	channel-to-channel matching; note 6		—	—	$\pm 1/2$	LSB
$V_{I(slope)}$	input voltage slope	$f_{clk} = 8$ MHz	−0.15	—	+0.15	V/ms

Notes

- All ADC inputs require an external divide-by-2 voltage divider.
- Gain error: the maximum difference between actual and ideal slope.
- Zero-offset error: the difference between the actual and ideal input voltage corresponding to the first actual code transition.
- Differential non-linearity: the difference between the actual and ideal code widths.
- Integral non-linearity: maximum deviation from straight line.
- Channel-to-channel matching: the difference between corresponding code transitions of actual characteristics taken from different channels under the same temperature, voltage and frequency conditions. Not tested, but verified on sampling basis.

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- (1) The ideal transfer curve.
- (2) The actual transfer curve.
- (3) Differential non-linearity (DNL).
- (4) Integral non-linearity (INL).
- (5) Gain error (G_e).

Fig.28 Analog-to-Digital conversion characteristics.

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27 AC CHARACTERISTICS

Table 56 Timing with respect to \overline{CE} , \overline{OE} and \overline{WE}

SYMBOL	PARAMETER	MIN.	TYP	MAX.	UNIT
General (see Fig.29)					
t_{XCLKH}	XCLK HIGH time	31.25	–	–	ns
t_{XCLKL}	XCLK LOW time	31.25	–	–	ns
$T_{cy}(XCLK)$	XCLK cycle time	62.5	–	–	ns
Memory Access (Figs 29 and 30)					
$t_{(CEL-OEL)1}$	\overline{CE} LOW to \overline{OE} LOW (data cycle)	–	–	$\frac{1}{2}t_{CLK} + 3$	ns
$t_{(OEL)1}$	\overline{OE} LOW time (data cycle)	–	–	$\frac{7}{2}t_{CLK} + 7$	ns
$t_{(CEH-OEH)1}$	\overline{CE} HIGH to \overline{OE} HIGH (data cycle)	0	–	12	ns
$t_{(CEL)1}$	\overline{CE} LOW time (data cycle)	–	–	$4t_{CLK}$	ns
$t_{(CEL-WEL)1}$	\overline{CE} LOW to \overline{WE} LOW (data cycle)	–	–	$\frac{1}{2}t_{CLK} + 5$	ns
$t_{(WEL)1}$	\overline{WE} LOW time (data cycle)	–	–	$\frac{7}{2}t_{CLK} + 8$	ns
$t_{(CEH-WEH)1}$	\overline{CE} HIGH to \overline{WE} HIGH (data cycle)	0	–	13	ns
$t_{su}(OE-D)2$	Data set-up time from \overline{OE} (data read cycle)	–	–	$3t_{CLK} - 18$	ns
$t_{su}(CEL-D)2$	Data set-up time from \overline{CE} LOW (data read cycle)	–	–	$\frac{7}{2}t_{CLK} - 18$	ns
$t_{su}(D-WEL)3$	Data set-up time to \overline{WE} LOW (data write cycle)	–	–	$\frac{1}{2}t_{CLK} - 3$	ns
$t_{(CEL-DV)3}$	Data valid time from \overline{CE} LOW (data write cycle)	–	–	3	ns
$t_{su}(D-SM)2$	Data set-up time to sample moment (data read cycle); note 1	–	–	8	ns
$t_h(SM-D)2$	Data hold time from sample moment (data read cycle); note 1	0	–	–	ns
$t_h(WEH-D)3$	Data hold time from \overline{WE} HIGH (data write cycle)	–	–	$t_{CLK} - 20$	ns
$t_h(CEH-D)3$	Data hold time from \overline{CE} HIGH (data write cycle)	–	–	$t_{CLK} - 10$	ns
$t_{su}(A-CEL)1$	Address set-up time to \overline{CE} LOW (data cycle)	–	–	$\frac{1}{2}t_{CLK} - 5$	ns
$t_h(CEH-A)1$	Address hold time from \overline{CE} HIGH (data cycle)	–	–	t_{CLK}	ns
$t_{(CEL-OEL)4}$	\overline{CE} LOW to \overline{OE} LOW (code fetch cycle)	–	–	$\frac{1}{2}t_{CLK}$	ns
$t_{(OEL)4}$	\overline{OE} LOW time (code fetch cycle)	–	–	$\frac{3}{2}t_{CLK}$	ns
$t_{(CEH-OEH)4}$	\overline{CE} HIGH to \overline{OE} HIGH (code fetch cycle)	0	–	2	ns

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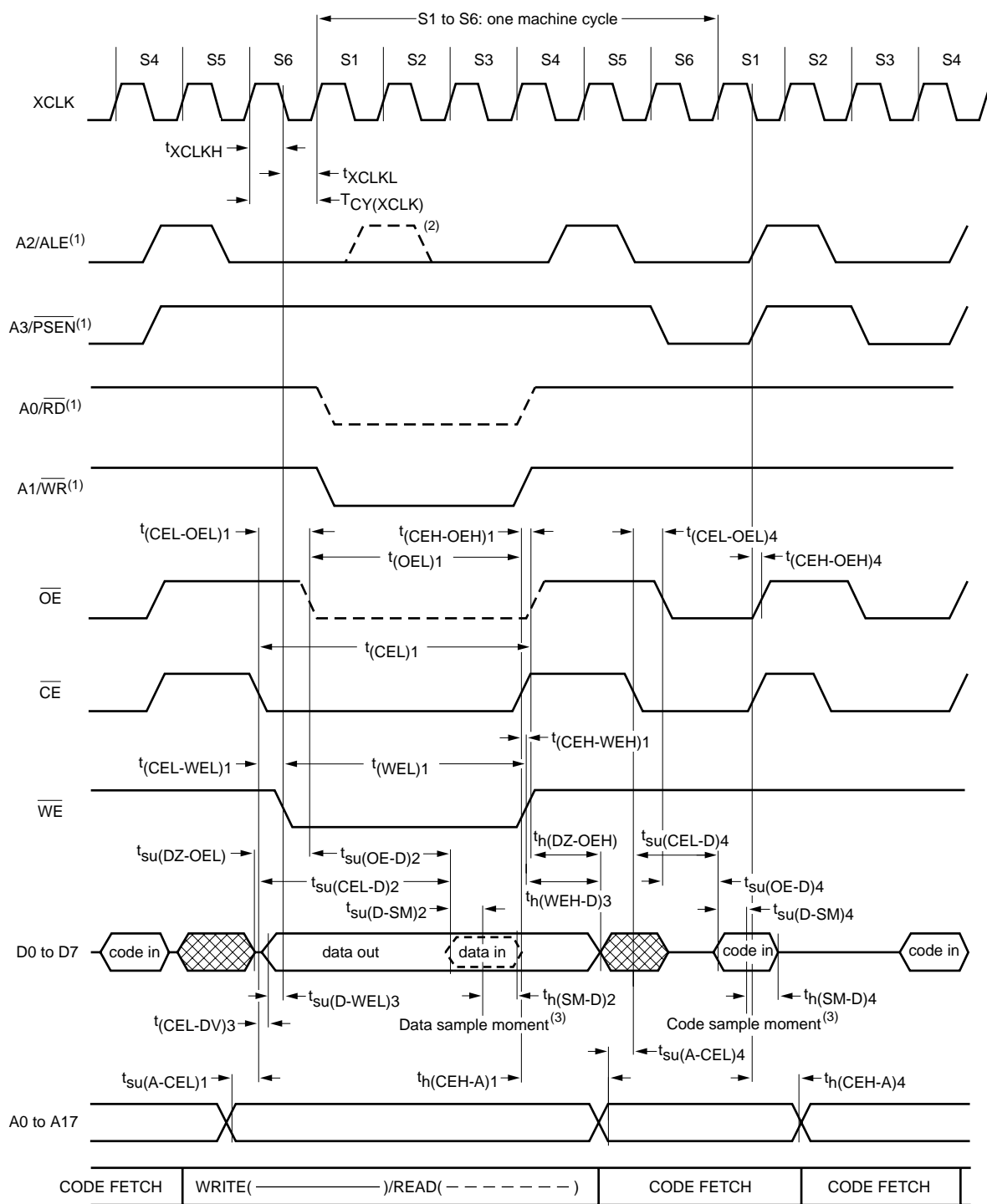
SYMBOL	PARAMETER	MIN.	TYP	MAX.	UNIT
$t_{(CEL)4}$	\overline{CE} LOW time (code fetch cycle)	–	–	$2t_{CLK}$	ns
$t_{su(OE-D)4}$	Data set-up time from \overline{OE} (code fetch cycle)	–	–	$\frac{3}{2}t_{CLK} - 18$	ns
$t_{su(CEL-D)4}$	Data set-up time from \overline{CE} LOW (code fetch cycle)	–	–	$2t_{CLK} - 18$	ns
$t_{su(D-SM)4}$	Data set-up time to sample moment (code fetch cycle), note 2	–	–	8	ns
$t_{h(SM-D)4}$	Data hold time from sample moment (code fetch cycle)	0	–	–	ns
$t_{su(DZ-OEL)}$	Data bus high-impedance set-up time to \overline{OE} LOW (data read cycle); (Code Fetch cycle)	$\frac{1}{2}t_{CLK} + 12$	–	–	ns
$t_{h(DZ-OEH)}$	Data bus high-impedance hold time from \overline{OE} HIGH (data read cycle); (code fetch cycle)	$\frac{1}{2}t_{CLK} - 2$; $t_{CLK} - 11$	–	–	ns
$t_{su(A-CEL)4}$	Address set-up time to \overline{CE} LOW (code fetch cycle)	–	–	$\frac{1}{2}t_{CLK} - 4$	ns
$t_{h(CEH-A)4}$	Address hold time from \overline{CE} HIGH (code fetch cycle)	–	–	$\frac{1}{2}t_{CLK}$	ns

Notes

1. Sample moment for data read cycles is on negative clock edge in state S3, the internal clock skew must be taken into account also. This results in $3t_{CLK} - 10$ ns from \overline{OE} LOW (or $\frac{7}{2}t_{CLK} - 10$ ns from \overline{CE} LOW) maximum.
2. Sample moment for code fetch cycles is on negative clock edge in state S2 or S4, the internal clock skew must be taken into account also. This results in $\frac{3}{2}t_{CLK} - 10$ ns from \overline{OE} LOW (or $2t_{CLK} - 10$ ns from \overline{CE} LOW) maximum.

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- (1) A0 to A3 alternative functions (\overline{PSEN} , ALE, \overline{WR} and \overline{RD}) show Debug mode timing; data bus carries low address on falling ALE edge.
 (2) Skipped ALE pulse because of MOVX instruction.
 (3) (Last) data sample moment.

Fig.29 External program memory access, w.r.t. \overline{CE} , \overline{OE} , and \overline{WE} .

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Table 57 Timing figures with respect to $\overline{\text{RAMCE}}$, $\overline{\text{OE}}$ and $\overline{\text{WE}}$

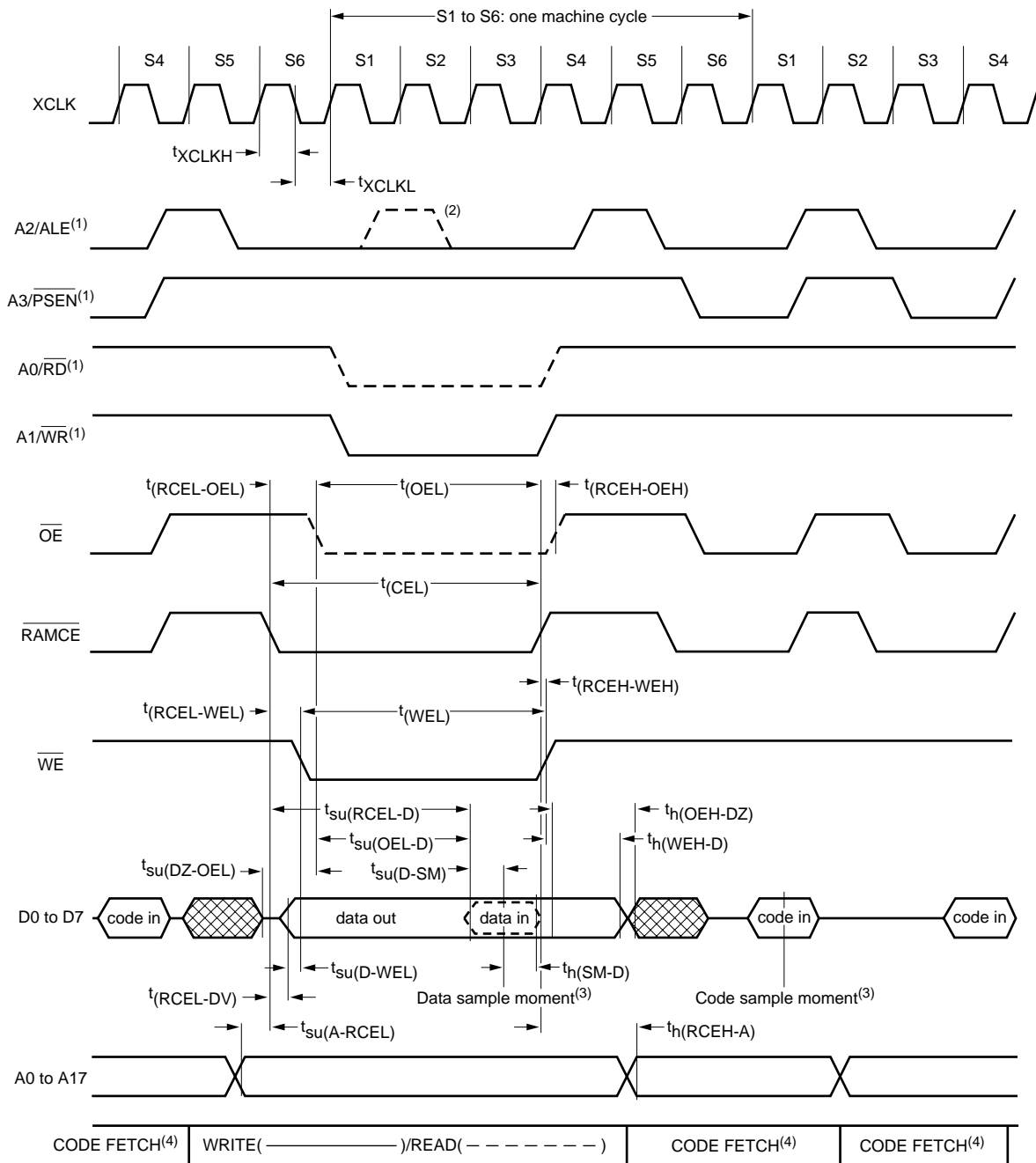
SYMBOL	PARAMETER	MIN.	TYP.	MAX.	UNIT
General (see Fig.29)					
t_{XCLKH}	XCLK HIGH time	31.25	–	–	ns
t_{XCLKL}	XCLK LOW time	31.25	–	–	ns
$T_{\text{cy}}(\text{XCLK})$	XCLK cycle time	62.5	–	–	ns
Memory Access (Figs 29 and 30)					
$t_{(\text{RCEL-OEL})}$	$\overline{\text{RAMCE}}$ LOW to $\overline{\text{OE}}$ LOW	–	–	$\frac{1}{2}t_{\text{CLK}} - 3$	ns
$t_{(\text{OEL})}$	$\overline{\text{OE}}$ LOW time	–	–	$\frac{7}{2}t_{\text{CLK}} + 8$	ns
$t_{(\text{RCEH-OEH})}$	$\overline{\text{RAMCE}}$ HIGH to $\overline{\text{OE}}$ HIGH	0	–	6	ns
$t_{(\text{RCEL})}$	$\overline{\text{RAMCE}}$ LOW time	–	–	$4t_{\text{CLK}} - 1$	ns
$t_{(\text{RCEL-WEL})}$	$\overline{\text{RAMCE}}$ LOW to $\overline{\text{WE}}$ LOW	–	–	$\frac{1}{2}t_{\text{CLK}} - 2$	ns
$t_{(\text{WEL})}$	$\overline{\text{WE}}$ LOW time	–	–	$\frac{7}{2}t_{\text{CLK}} + 7$	ns
$t_{(\text{RCEH-WEH})}$	$\overline{\text{RAMCE}}$ HIGH to $\overline{\text{WE}}$ HIGH	0	–	7	ns
$t_{\text{su}}(\text{OEL-D})$	Data set-up time from $\overline{\text{OE}}$ LOW	–	–	$3t_{\text{CLK}} - 18$	ns
$t_{\text{su}}(\text{RCEL-D})$	Data set-up time from $\overline{\text{RAMCE}}$ LOW	–	–	$\frac{7}{2}t_{\text{CLK}} - 20$	ns
$t_{\text{su}}(\text{D-WEL})$	Data set-up time to $\overline{\text{WE}}$ LOW	–	–	$\frac{1}{2}t_{\text{CLK}} + 3$	ns
$t_{(\text{RCEL-DV})}$	Data valid time from $\overline{\text{RAMCE}}$ LOW	–	–	4	ns
$t_{\text{su}}(\text{D-SM})$	Data set-up time to sample moment, note 1	–	–	8	ns
$t_{\text{h}}(\text{SM-D})$	Data hold time from sample moment; note 1	0	–	–	ns
$t_{\text{h}}(\text{WEH-D})$	Data hold time from $\overline{\text{WE}}$ HIGH	–	–	$t_{\text{CLK}} - 7$	ns
$t_{\text{h}}(\text{RCEH-D})$	Data hold time from $\overline{\text{RAMCE}}$ HIGH	–	–	$t_{\text{CLK}} - 14$	ns
$t_{\text{su}}(\text{A-RCEL})$	Address set-up time to $\overline{\text{RAMCE}}$ LOW	–	–	$\frac{1}{2}t_{\text{CLK}}$	ns
$t_{\text{h}}(\text{RCEH-A})$	Address hold time from $\overline{\text{RAMCE}}$ HIGH	–	–	$t_{\text{CLK}} - 7$	ns
$t_{\text{su}}(\text{DZ-OEL})$	Data bus high-impedance set-up time to $\overline{\text{OE}}$ LOW	$\frac{1}{2}t_{\text{CLK}} + 1$	–	–	ns
$t_{\text{h}}(\text{OEH-DZ})$	Data bus high-impedance hold time from $\overline{\text{OE}}$ HIGH	$\frac{1}{2}t_{\text{CLK}} - 10$	–	–	ns

Notes

1. Sample moment for data read cycles is on negative clock edge in state S3, the internal clock skew must be taken into account also. This results in $3t_{\text{CLK}} - 10$ ns from $\overline{\text{OE}}$ LOW (or $\frac{7}{2}t_{\text{CLK}} - 10$ ns from $\overline{\text{RAMCE}}$ LOW) maximum.

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- (1) A0 to A3 alternative functions ($\overline{\text{PSEN}}$, $\overline{\text{ALE}}$, $\overline{\text{WR}}$ and $\overline{\text{RD}}$) show Debug mode timing (Data bus carries low address on falling ALE edge).
- (2) Skipped ALE pulse because of MOVX instruction.
- (3) (Last) data sample moment.
- (4) Code fetch only if CE is active (not shown). CE and RAMCE are never active at the same time.

Fig.30 External RAM access w.r.t. $\overline{\text{RAMCE}}$, $\overline{\text{OE}}$ and $\overline{\text{WE}}$.

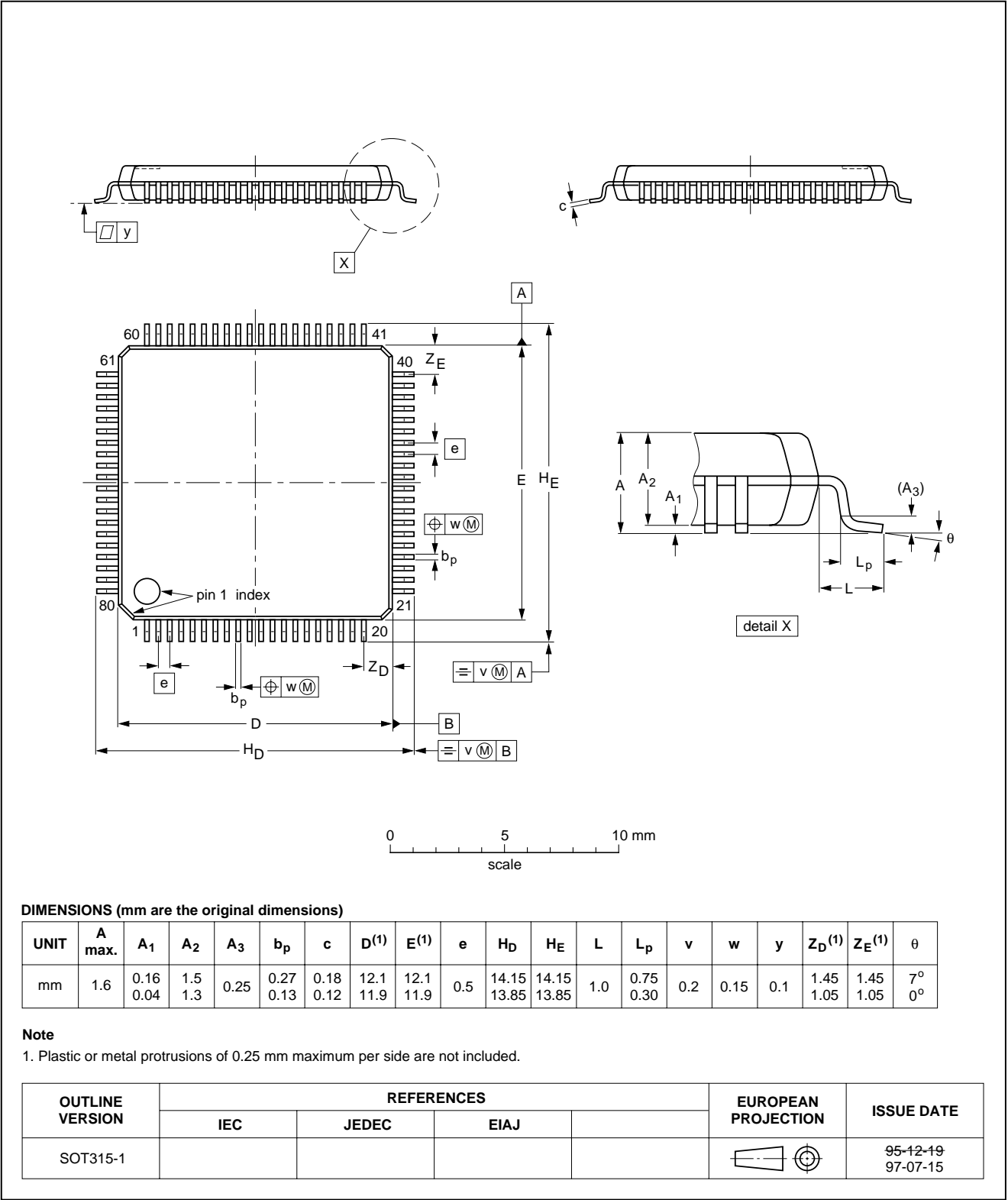
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28 PACKAGE OUTLINE

LQFP80: plastic low profile quad flat package; 80 leads; body 12 x 12 x 1.4 mm

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29 SOLDERING

29.1 Introduction

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mounted components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mounted ICs, or for printed-circuits with high population densities. In these situations reflow soldering is often used.

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our *“Data Handbook IC26; Integrated Circuit Packages”* (order code 9398 652 90011).

29.2 Reflow soldering

Reflow soldering techniques are suitable for all LQFP packages.

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement.

Several methods exist for reflowing; for example, infrared/convection heating in a conveyor type oven. Throughput times (preheating, soldering and cooling) vary between 50 and 300 seconds depending on heating method. Typical reflow peak temperatures range from 215 to 250 °C.

29.3 Wave soldering

Wave soldering is **not** recommended for LQFP packages. This is because of the likelihood of solder bridging due to closely-spaced leads and the possibility of incomplete solder penetration in multi-lead devices.

CAUTION
Wave soldering is NOT applicable for all LQFP packages with a pitch (e) equal or less than 0.5 mm.

If wave soldering cannot be avoided, for LQFP packages with a pitch (e) larger than 0.5 mm, the following conditions must be observed:

- A double-wave (a turbulent wave with high upward pressure followed by a smooth laminar wave) soldering technique should be used.
- The footprint must be at an angle of 45° to the board direction and must incorporate solder thieves downstream and at the side corners.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Maximum permissible solder temperature is 260 °C, and maximum duration of package immersion in solder is 10 seconds, if cooled to less than 150 °C within 6 seconds. Typical dwell time is 4 seconds at 250 °C.

A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

29.4 Repairing soldered joints

Fix the component by first soldering two diagonally-opposite end leads. Use only a low voltage soldering iron (less than 24 V) applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 °C. When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320 °C.

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30 DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

31 LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

32 PURCHASE OF PHILIPS I²C COMPONENTS



Purchase of Philips I²C components conveys a license under the Philips' I²C patent to use the components in the I²C system provided the system conforms to the I²C specification defined by Philips. This specification can be ordered using the code 9398 393 40011.

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NOTES

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Philips Semiconductors – a worldwide company

Argentina: see South America

Australia: 34 Waterloo Road, NORTH RYDE, NSW 2113,
Tel. +61 2 9805 4455, Fax. +61 2 9805 4466

Austria: Computerstr. 6, A-1101 WIEN, P.O. Box 213, Tel. +43 160 1010,
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Belarus: Hotel Minsk Business Center, Bld. 3, r. 1211, Volodarski Str. 6,
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Tel. +1 800 234 7381

China/Hong Kong: 501 Hong Kong Industrial Technology Centre,
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Colombia: see South America

Czech Republic: see Austria

Denmark: Prags Boulevard 80, PB 1919, DK-2300 COPENHAGEN S,
Tel. +45 32 88 2636, Fax. +45 31 57 0044

Finland: Sinikalliontie 3, FIN-02630 ESPOO,
Tel. +358 9 615800, Fax. +358 9 61580920

France: 51 Rue Carnot, BP317, 92156 SURESNES Cedex,
Tel. +33 1 40 99 6161, Fax. +33 1 40 99 6427

Germany: Hammerbrookstraße 69, D-20097 HAMBURG,
Tel. +49 40 23 53 60, Fax. +49 40 23 536 300

Greece: No. 15, 25th March Street, GR 17778 TAVROS/ATHENS,
Tel. +30 1 4894 339/239, Fax. +30 1 4814 240

Hungary: see Austria

India: Philips INDIA Ltd, Band Box Building, 2nd floor,
254-D, Dr. Annie Besant Road, Worli, MUMBAI 400 025,
Tel. +91 22 493 8541, Fax. +91 22 493 0966

Indonesia: PT Philips Development Corporation, Semiconductors Division,
Gedung Philips, Jl. Buncit Raya Kav.99-100, JAKARTA 12510,
Tel. +62 21 794 0040 ext. 2501, Fax. +62 21 794 0080

Ireland: Newstead, Clonskeagh, DUBLIN 14,
Tel. +353 1 7640 000, Fax. +353 1 7640 200

Israel: RAPAC Electronics, 7 Kehilat Saloniki St, PO Box 18053,
TEL AVIV 61180, Tel. +972 3 645 0444, Fax. +972 3 649 1007

Italy: PHILIPS SEMICONDUCTORS, Piazza IV Novembre 3,
20124 MILANO, Tel. +39 2 6752 2531, Fax. +39 2 6752 2557

Japan: Philips Bldg 13-37, Kohnan 2-chome, Minato-ku,
TOKYO 108-8507, Tel. +81 3 3740 5130, Fax. +81 3 3740 5077

Korea: Philips House, 260-199 Itaewon-dong, Yongsan-ku, SEOUL,
Tel. +82 2 709 1412, Fax. +82 2 709 1415

Malaysia: No. 76 Jalan Universiti, 46200 PETALING JAYA, SELANGOR,
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Mexico: 5900 Gateway East, Suite 200, EL PASO, TEXAS 79905,
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Middle East: see Italy

Netherlands: Postbus 90050, 5600 PB EINDHOVEN, Bldg. VB,
Tel. +31 40 27 82785, Fax. +31 40 27 88399

New Zealand: 2 Wagener Place, C.P.O. Box 1041, AUCKLAND,
Tel. +64 9 849 4160, Fax. +64 9 849 7811

Norway: Box 1, Manglerud 0612, OSLO,
Tel. +47 22 74 8000, Fax. +47 22 74 8341

Pakistan: see Singapore

Philippines: Philips Semiconductors Philippines Inc.,
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Poland: Ul. Lukiska 10, PL 04-123 WARSZAWA,
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Tel. +55 11 821 2333, Fax. +55 11 821 2382

Spain: Balmes 22, 08007 BARCELONA,
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Taiwan: Philips Semiconductors, 6F, No. 96, Chien Kuo N. Rd., Sec. 1,
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Turkey: Talatpasa Cad. No. 5, 80640 GÜLTEPE/ISTANBUL,
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Ukraine: PHILIPS UKRAINE, 4 Patrice Lumumba str., Building B, Floor 7,
252042 KIEV, Tel. +380 44 264 2776, Fax. +380 44 268 0461

United Kingdom: Philips Semiconductors Ltd., 276 Bath Road, Hayes,
MIDDLESEX UB3 5BX, Tel. +44 181 730 5000, Fax. +44 181 754 8421

United States: 811 East Arques Avenue, SUNNYVALE, CA 94088-3409,
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